

# HP 3000/930 and HP 9000/840 Computers CE Handbook

# HP 3000/930 and HP 9000/840 Computers

### **CE Handbook**



Manual Part Number: 09740-90023 Printed in U.S.A. November 1986

#### NOTICE

The information contained in this document is subject to change without notice.

HEWLETT-PACKARD MAKES NO WARRANTY OF ANY KIND WITH REGARD TO THIS MATERIAL, INCLUDING, BUT NOT LIMITED TO THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE. Hewlett-Packard shall not be liable for errors contained herein or for incidental or consequential damages in connection with the furnishing, performance or use of this material.

Hewlett-Packard assumes no responsibility for the use or reliability of its software on equipment that is not furnished by Hewlett-Packard.

This document contains propriety information which is protected by copyright. All rights are reserved. No part of this document may be photocopied, reproduced or translated to another language without the prior written consent of Hewlett-Packard Company.

UNIX is a trademark of AT&T Laboratories in the USA and other countries.

Copyright (c) 1982-1986 by HEWLETT-PACKARD COMPANY

### **PRINTING HISTORY**

New editions are complete revisions of the manual. Update packages, which are issued between editions, contain additional and replacement pages to be merged into the manual by the customer. The dates on the title page change only when a new edition or a new update is published. No information is incorporated into a reprinting unless it appears as a prior update; the edition does not change when an update is incorporated.

The software code printed alongside the date indicates the version level of the software product at the time the manual or update was issued. Many product updates and fixes do not require manual changes and, conversely, manual corrections may be done without accompanying product changes. Therefore, do not expect a one to one correspondence between product updates and manual updates.

First Edition . . . . Nov 1986

### LIST OF EFFECTIVE PAGES

The List of Effective Pages gives the date of the most recent version of each page in the manual. To verify that your manual contains the most current information, check the dates printed at the bottom of each page with those listed below. The date on the bottom of each page reflects the edition or subsequent update in which that page was printed.

Effective Pages		Date
all	 	. Nov 1986

# **CONTENTS**

Pag PREFACE	ęе
Reference Documents	11
Section 1 PRODUCT INFORMATION	
System Specifications         1-           Central Processing Unit (CPU)         1-           System Monitor Card         1-           System Capacity         1-           System Color Code Organization         1-           System Orientation         1-           System Status Display Panels         1-1	7 8 8 9
Section 2 ENVIRONMENTAL/INSTALLATION/ PREVENTIVE MAINTENANCE	
Environmental Specifications         2-           Physical Specifications         2-           Electrical Specifications         2-           Installation         2-           Hardware Installation Checklist         2-           Device Adapters         2-           Preventive Maintenance         2-	2 3 4 4 5
Section 3 CONFIGURATION	
CPU Card Cage Configuration Assignment	7
Section 4 TROUBLESHOOTING	
System Display Status Codes         4-           SPU Troubleshooting         4-1           Troubleshooting Procedures         4-1           DC Power Supply Check         4-1           Power Supply Troubleshooting         4-1           Selftest Switch Settings         4-1           Selftest as a Troubleshooting Tool         4-2	1 1 2 3

# CONTENTS (continued)

ection 5 MAGNOSTICS	Page
IP 9740A SPU Selftest	5-2
Selftest Display	
Diagnostic/Utility Orientation	
Diagnostic User Interface (DUI)	
Mini-Operating Instructions.	
CS/80 Disc Diagnostic (CS80DIAG)	
Mini-Operating Instructions.	
HP 7974A and 7978A/B Magnetic Tape Drive Diagnostic (DIAG7478)	
Mini-Operating Instructions.	
Ciper Line Printer Diagnostic (CIPERLPD)	
Mini-Operating Instructions.	
HP-IB Device Adapter Diagnostic (HPIBDIAG).	
Mini-Operating Instructions.	
Memory Array Diagnostic (MEMDIAG)	
Mini-Operating Instructions	
Asynchronous Six-Channel Multiplexer Diagnostic (MUXDIAG)	
Mini-Operating Instructions.	
Local Area Network Device Adapter Diagnostic (LANDAD)	
Mini-Operating Instructions	
I/O Test Tool (IOTT)	
Mini-Operating Instructions.	
COMMAND SUMMARY	_
Control Commands (CC)	
User Program File Commands(UPFC)	
Program Editing Commands(PEC)	
Miscellaneous Commands(MC).	
INSTRUCTION SUMMARY	
Test Environment Instructions(TEI)	
Buffer Manipulation Instructions(BMI)	
Predefined I/O Request Instructions(PIORI)	
HP-IB Device Adapter Program Instructions(HPIBPI)	
HP-CIO DMA Chain Instructions(HPCIOI).	
PROGRAM STATEMENT SUMMARY	
HP-CIO Channel Adapter Utility (CADIAG)	
Mini-Operating Instructions.	
System and Memory Log Analysis Tool (LOGTOOL)	
Mini-Operating Instructions	
System Map (SYSMAP)	
Mini-Operating Instructions.	
HP-UX Logging Facility	
Mini-Operating Instructions.	
MPE-XL Online Diagnostic Installer	
Mini-Operating Instructions.	

# CONTENTS (continued)

	Page
MPE-XL Online Diagnostic Implementation Implementation Dependent Information MPE-XL Specific Diagnostic Procedures/Features HP-UX Online Diagnostic Implementation Implementation Dependent Information HP-UX Specific Diagnostic Procedures/Features	5-26 5-26 5-27 5-27
Section 6 ADJUSTMENTS	
Power Supply Removal/Replacement - Power Supply #1	
Section 7 PERIPHERALS	7-1
Section 8 REPLACEABLE PARTS	
Replaceable Parts Catalog	. 8-7
Section 9 DIAGRAMS	
Overall Block Diagram - 9740 CPU	. 9-5
Series 900 Model 930 Block Diagram.  Power Distribution Chart.  Power Distribution System	. 9-9
Expansion Bay/Module Block Diagram.  Expansion Bay Power Distribution Chart  Expansion Bay Power Distribution System.	9-13
Cache Unit (CA+) Block Diagram  Execution Unit (EU+) Block Diagram  Floating Point Unit (FP) Block Diagram	9-15 9-16
Instruction Unit (IU) Block Diagram  Register File Unit (RF) Block Diagram  Translation Lookaside Buffer (TL+) Block Diagram	9-18 9-19
System Monitor Module Front Cabinet PCAs.	9-21 9-22
HP 9000 Series 800 Model 840 Front/Rear Cabinet PCAs	

# **CONTENTS** (continued)

Pa	ge
ystem Monitor Card Backplane Connectors	26
ystem Monitor Card Front Panel Connectors	27
ection 10 EFERENCE 10	-1
	Ī
ection 11 ERVICE NOTES	
Notes	- 1
Notes	-2
Notes	- 3
Notes	-4
Notes	- 5
Notes	-6

# FIGURES AND TABLES

LIST OF FIGURES	Page
HP 3000/930 Functional Diagram	. 1-3
HP 9000/840 Functional Diagram	. 1-5
Cabinet, Front View (Door Removed)	. 1-9
Cabinet, Rear View (Door Removed)	1-10
External and Internal System Status Display Panels	1-11
System Card Cage Location	
CPU Card Slot Assignments	. 3-6
Channel I/O Card Slot Assignments	. 3-8
Memory Array and Memory Controller Slot Assignments	. 3-9
System Status Display Panels	. 4-2
Expansion Bay Module System Status Display Panels	. 4-5
Hexidecimal Display Panel	
Power System Troubleshooting Flowchart 1	4-14
Power System Troubleshooting Flowchart 2	4-15
Power System Troubleshooting Flowchart 3	4-16
Power System Troubleshooting Flowchart 4	4-17
Power System Troubleshooting Flowchart 5	4-18
Power System Troubleshooting Flowchart 6	4-19
Selftest Operation Flowchart 1	4-20
Selftest Operation Flowchart 2	4-21
Selftest Operation Flowchart 3	
Selftest Operation Flowchart 4	4-23
Selftest Operation Flowchart 5	4-24
Selftest Operation Flowchart 6	
Selftest Operation Flowchart 7	4-26
Location of Power Supplies	. 6-3
SPU, Front View	. 8-3
SPU, Rear View	. 8-5
Power Distribution Matrix for Card Slots	9-10
System Monitor Board Connector Location	9-26

# FIGURES AND TABLES (continued)

LIST OF TABLES	Page
CPU Specifications	. 1-7
System Monitor Specifications	
CPU and Mid-Bus Card Cage Capacity	. 1-8
Channel I/O Card Cage Capacity	. 1-8
System Color Code	
Configuration Switch Definitions (HP 27110B/HP 27113A)	. 2-5
Preventive Maintenance Schedule	. 2-6
Minimum Hardware Configuration (All Systems)	. 3-2
Maximum Peripheral Devices for System Configuration	. 3-3
System Card Cage Configuration	. 3-4
External System Control Panel	
Internal System Control Panel	
Expansion Module Internal Display Panel	
Expansion Module External Display Panel	
Class Error Descriptions	
Selftest Error Codes	
Power Supply Test Points	
Selftest Switch Settings	
Supported Diagnostic Programs	
Supported Subsystem Utilities	
MPE-XL Default Device Configuration	
HP-UX Default Device Configuration	
Exchange Parts	
Non-Exchange Parts (1 of 2)	
Non-Exchange Parts (2 of 2)	
ASCII Code Table	10-1

#### **PREFACE**

The Customer Engineer Handbook is a reference guide for the Customer Engineer (CE). It provides specifications, procedures, replaceable parts list, troubleshooting data, and applicable reference information. This handbook is divided into sections to logically arrange data into subject groups.

The Product Information section contains functional block diagrams (HP 3000 Series 900 Model 930 and HP 9000 Series 800 Model 840), system specifications, system orientation, control panel information, and power system information.

The Environmental, Installation, and Preventive Maintenance (PM) section provides reference to applicable manuals for installation procedures, as well as describes environmental requirements and preventive maintenance procedures.

The Configuration section provides hardware data required to operate a standard configuration of the HP 3000 Series 900 Model 930 and HP 9000 Series 800 Model 840 Computer Systems.

The Troubleshooting section contains information on LED status indicators, Expansion Bay Module LED status indicators, system display status codes, error descriptions, flowcharts for SPU troubleshooting and selftest as a troubleshooting tool.

The Diagnostic Section provides information pertaining to the diagnostics used for the HP-UX and MPE-XL operating systems. Reference material for detailed diagnostic procedures is also provided.

The Adjustments section contains procedures required to remove/replace the system power supply.

The Peripherals section contains default device configuration information supported on the HP 3000 Series 900 Model 930 and HP 9000 Series 800 Model 840 Computer Systems.

The Replaceable Parts section contains a Replaceable Parts Catalog that provides illustrations and parts lists to assist with parts replacement procedure.

The Diagrams section contains selected hardware drawings to aid the CE in isolating system faults.

The Reference section contains conversion charts and acronyms to aid the CE in troubleshooting.

The Service Note section is a depository for special procedures and troubleshooting data developed in the field.

The information which refers specifically to HP-UX or MPE-XL is cited, all other information applies to both.

#### REFERENCE DOCUMENTS

The hardware documentation supporting the HP 3000/930 and HP 9000/840 Computer Systems is listed below. Reference these manuals when additional information is required.

Hardware Support Manual, Part Number 09740-90011.

Site Preparation and Requirements Guide, Part Number 09740-90018.

Installation and Configuration Guide, Part Number 09740-90019.

Online Diagnostics Subsystem Manual, Part Number 09740-90020.

Online Diagnostics Subsystem Utilities Manual, Part Number 09740-90021.

Expansion Bay/Module Support Manual, Part Number 32480-90001.

System Support Log, Part Number 09740-90013.

Reference Training Manual, Part Number 09740-90022.

HP Precision Architecture and Instruction Reference Manual, Part Number 09740-90014.

Precision Architecture Procedure Calling Conventions Reference Manual, Part Number 09740-90015.

HP 19748A Add-on Memory Installation and Configuration Guide, Part Number 19748-90001.

HP 19749A Cable Management System Installation Guide, Part Number 19749-90001.

HP 19744A Add-on Channel Installation Guide, Part Number 19744-90001.

Interface and Networking Cards Manual, Part Number 09740-64011.

Peripherals and Accessories Manual, Part Number 09740-90012.

System Operation - System Startup and Shutdown Guide, Part Number 32650-90034.

System Operation - Backup and Disaster Recovery Guide, Part Number 32650-90039.

HP 9000/840 System Administrators Manual, Part Number 92453-90004.

### PRODUCT INFORMATION

SECTION

This section provides an overview for the HP 3000/930 and 9000/840 computer systems functional block diagrams, system specifications, system orientation, and system status display panel information.

System Specifications				 											 		1-7
Central Processing Unit (CPU).		 		 											 		1-7
System Monitor Card		 		 											 		1-7
System Capacity		 		 											 		1-8
System Color Code Organization		 		 											 		1-8
System Orientation				 											 		1-9
System Status Display Panels		 		 											 	. :	-11

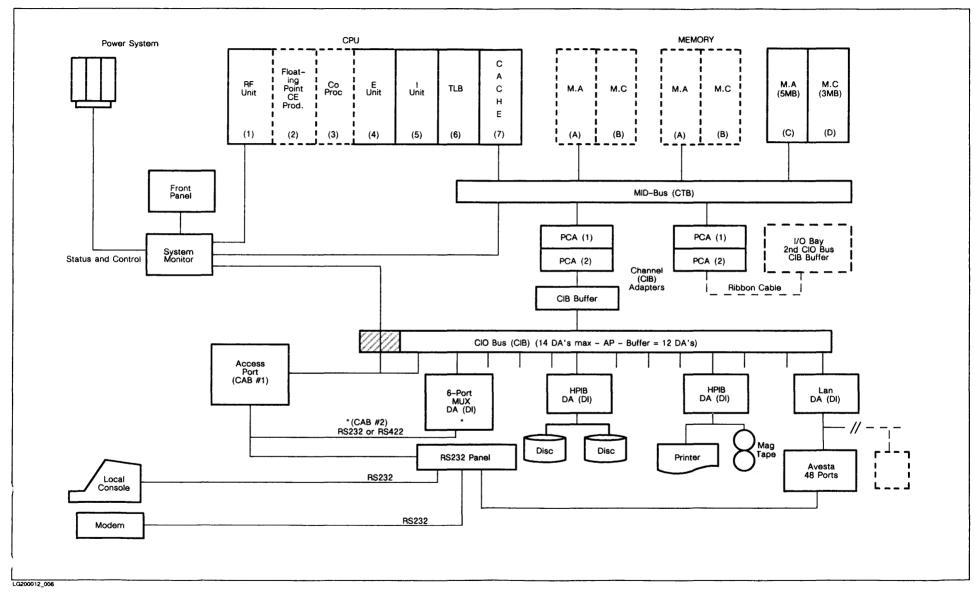


Figure 1-1. HP 3000/930 Functional Diagram

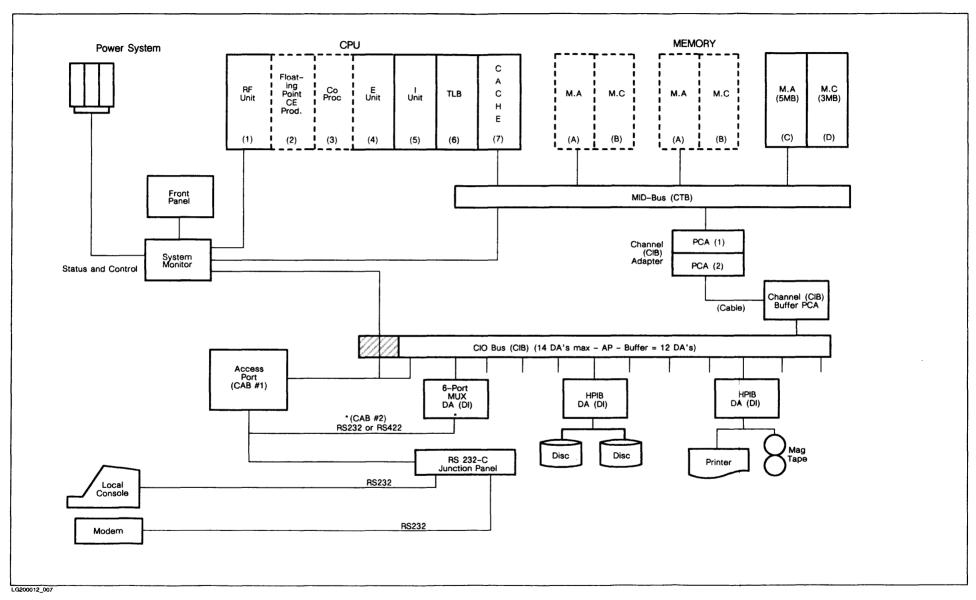


Figure 1-2. HP 9000/840 Functional Diagram

#### SYSTEM SPECIFICATIONS

HP Precision Architecture Computer Systems share a common architecture and instruction set. The instruction set is hardwired to speed up instruction decoding operations. See Figures 1-1 and 1-2 for the HP 3000/930 and HP 9000/840 functional block diagrams. The processor uses a TTL processing unit technology. The following is a listing of general System Processor Unit (SPU) specifications.

#### Central Processing Unit (CPU)

Table 1-1. CPU Specifications

Word Length	32 bits
Virtual Memory Address Space	48 bits
Physical Memory Address Space	27 bits
Instruction Set (with Floating Point Coprocessor)	127 instructions (167 instructions)
Cycle Time	125 nanoseconds
Mid-Bus Bandwidth	32 Mb per second (raw) 15 - 20 Mb per second (typical)

#### System Monitor Card

Table 1-2. System Monitor Specifications

Lithium Battery Service Life	10 years
Divinion Buccory Service Ente	10 years

#### **System Capacity**

Table 1-3. CPU and Mid-Bus Card Cage Capacity

Processor Boards (RF, EU+, IU, TLB, CA+)	5
Coprocessor Boards	2
CIO Channel Adapter (two cards per channel) (See NOTE)	3 sets
General Purpose Mid-Bus Cards (See NOTE)	5
Memory Boards	6

NOTE

The total sum of the CIO Channel Adapter Cards (with two cards per channel) plus general purpose Mid-Bus Cards in the CPU Card Cage cannot be greater than seven cards.

Table 1-4. Channel I/O Card Cage Capacity

CIO Cards	12
Access Port (Console Attachment Board #1)	1
Channel Buffer Card (CIB Attachment Board)	1

#### **System Color Code Organization**

Table 1-5. System Color Code

Functional Area (Card Slot Qty.)	Color Code
CIO (14)	Orange
Mid-Bus (7)	Blue
Memory (6)	Pink
CPU (7)	Purple
System Monitor Module	Monitor Mustard
Power Supply Module - 3 ea.	White

#### SYSTEM ORIENTATION

Provided in Figure 1-3 and 1-4 are front and rear views of the SPU.

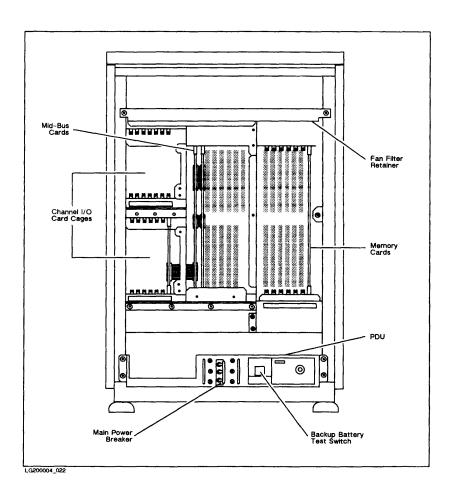


Figure 1-3. Cabinet, Front View (Door Removed)

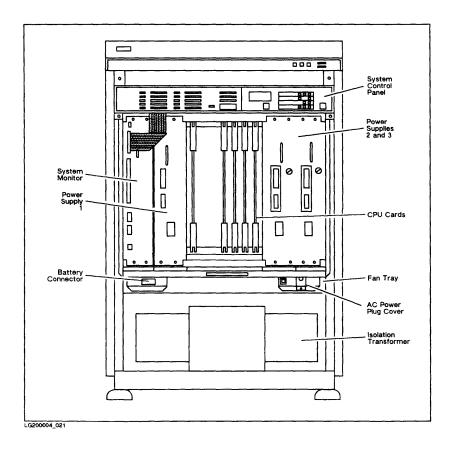


Figure 1-4. Cabinet, Rear View (Door Removed)

#### SYSTEM STATUS DISPLAY PANELS

The external and internal system status display panels are illustrated in Figure 1-5. Refer to Troubleshooting in Section 4 for Indicator/Status description information.

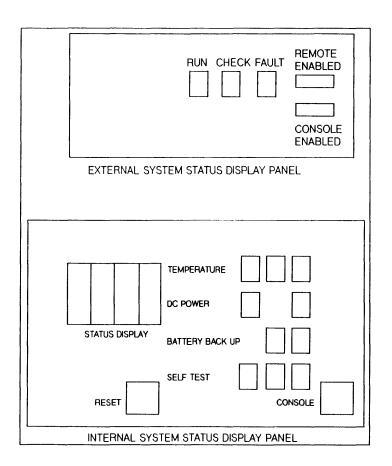


Figure 1-5. External and Internal System Status Display Panels

# ENVIRONMENTAL/INSTALLATION/PREVENTIVE MAINTENANCE

SECTION

This section contains information on environmental specifications, installation, and preventive maintenance.

Environmental Specifications	 					 				 						 2	-2
Physical Specifications	 									 						 2	-2
Electrical Specifications						 				 						 2	- 3
Installation	 					 				 						 2	-4
Hardware Installation Checklist	 					 				 						 2	-4
Device Adapters	 					 				 						 2	- 5
Preventive Maintenance																 2	-6

#### **ENVIRONMENTAL SPECIFICATIONS**

The environmental specifications include physical and electrical specifications.

#### **Physical Specifications**

ensions:	

 Height:
 1.0 meters (39 inches)

 Width:
 0.6 meters (23.4 inches)

Depth: 0.8 meters (31.2 inches)

Weight: 162 Kg (357 lbs.)

Altitude:

Operating: 0-4,600 meters (0-15,000 feet)

Nonoperating: 0-15,300 meters (0-50,000 feet)

Environment:

Operating Temperature: 0 to 55 deg C (32 to 131 deg F)

Nonoperating (Shipping/Storage): -40 to 70 deg C (-40 to 158 deg F)

Rate of Temperature Change: 20 deg C/hr (68 deg F/hr) max.

Operating Humidity: 5%-90% at 40 deg C (95 deg F)

(non-condensing)

Nonoperating Humidity: 90% at 65 deg C (149 deg F)

(non-condensing)

EMI Susceptibility: 1 Volt/Meter at 14 KHZ - 1 GHZ

#### **Electrical Specifications**

System Power:

Nominal Voltage: 200V, 208V, 230V, 240V AC

Voltage Tolerance: +/- 15% of Nominal Voltage

Input Frequency: 50 or 60 Hz Nom, 47.5 - 66 Hz

Line Distortion: < 10% Total Harmonic Distortion

Rated Maximum Input Current: 13 Ampheres

Wattage: 2000 Watts (w/expansion bay)

Surge Current: < 125 Ampheres

Power Line Transients: Tested to IEEE Standard 587 (Category B).

Power Connections: NEMA L6-20P (plug)

Heat Generation: 6,824 BTUs (w/expansion bay)

#### INSTALLATION

System installation procedures for the CE are not provided in this manual due to their level of detail. Refer to the Installation and Configuration Guide (P/N 09740-90019) for installation procedures which apply to the Hardware Installation Checklist provided below.

#### Hardware Installation Checklist

- Install I/O Extender Bay (Optional).
- Install Floating Point Coprocessor (Optional).
- Install System Cables.
- Install Synapse Boxes (Optional).
- Install System Console.
- Install Disc Drive.
- Install Peripheral Devices.
- Check Power Supply Voltages.
- Run Computer Selftest.
- Install Operating System.
- Backup System.
- Run System Verification.
- · Check Power Fail Recovery System.

#### **Device Adapters**

Device adapters provide an interface between peripheral devices and the CIO bus. The supported device adapters are:

- HP 27113A Commercial HP-IB Device Adapter.
- HP 27110B Technical HP-IB Card.
- HP 27112A General Purpose I/O (GPIO) Card.
- OEM Programmable Serial Interface Card.
- Programmable Serial Interface, Remote Job Entry.
- HP 27140A Six-Channel Multiplexer for terminals.
  HP 27125A (IEEE 802. 3) Local Area Network Interface Card (LANIC).
- HP 27114A Asynchronous FIFO Interface (AFI) Card.

Table 2-2. Configuration Switch Definitions (HP 27110B/HP 27113A)

Swit	ch	F	unction		S	ettings						
S1 (8	3)	Not Use	ed .									
S1 (7	7)	Data Se Time Se	etting election		Up = Medium/Slow Speed DOWN = High Speed							
S1 (6	3)	System Selection	Controller		UP = System Controller DOWN = Not System Controlle							
S1(1) -	S1 (5)			ge)	S1(5) = MSB S1(1) = LSB UP = Logic One = Open DOWN = Logic Zero = Closed							
Th	e factory s	ettings for	the configu	ration swit	ches are as	follows:						
S1(1)	S1(2)	S1 (3)	S1 (4)	S1 (5)	S1(6)	S1 (7)	S1 (8)					
DOWN	UP	UP	UP	UP	UP	DOWN	Don't Care					

LG200012\_010

#### PREVENTIVE MAINTENANCE

Preventive Maintenance (PM) is performed periodically to ensure the system will operate continuously without failures. Refer to the Hardware Support Manual (P/N 09740-90011) for detailed procedure information concerning Preventive Maintenance (Chapter 4) or Removal and Replacement (Chapter 6).

The following maintenance schedule is recommended for sustained performance of the computer system.

#### NOTE

Before maintenance on the system is started, verify that the System Operator has backed-up all files, users are logged off, and an operating system shutdown was performed before powering down system.

Table 2-3. Preventive Maintenance Schedule

SCHEDULE ASSEMBLY	EVERY 12 MONTHS
Fans (4)	Check fan operation, replace as necessary.
Air Filter (P/N 3150-0504)	Replace.
System Control Panel LEDs	Press and hold RESET button on System Control Panel. Observe all LEDs are ON. If any LEDs are not ON, replace System Control Panel Display Card.
DC Power Supply	Verify voltages at System Monitor Card test points. Refer to Table 4-6 (Troubleshooting, Section 4). Replace power supply if not within normal specification.
Backup Battery - lead acid (P/N 09740-60007)	Test battery and replace as necessary.
System Monitor Module Batteries (2) - lithium (P/N 1420-0341)	Test both batteries and replace as necessary.

#### WARNING

Observe all WARNING - HAZARDOUS VOLTAGE labels. Hazardous voltages are present inside the computer mainframe. Refer to Hardware Support Manual (P/N 09740-90011) for detailed information on handling assemblies.

# **CONFIGURATION**



This section provides hardware data required to operate a standard configuration of the HP 3000/930 and 9000/840 Computer Systems.

CPU Card Cage Configuration Assignment	3-6
CIO Card Cage Configuration Assignment	3-7
Memory Card Cage Configuration Assignment	3-9

#### Configuration

The minimum hardware configuration that is required to support the HP 3000/930 or HP 9000/840 Computer Systems is provided in Table 3-1.

Table 3-1. Minimum Hardware Configuration (All Systems)

Quantity (MPE-XL)	Quantity (HP-UX)	HP Product#	Description
1	1	9740A	SPU (HP-UX is HP Product # 9741A)
1	1	19742A	Floating Point Coprocessor
2	1	19744A	Channel Set (3 cards each set)
1		19746A	Expansion Module
1		19747A	Expansion Bay
2	1	19748A	8M Byte Memory
1	1	30192A	Access Port
x	x	I/O Cards	CIO Interface Cards (Quantity to support peripherals)

The minimum peripheral hardware needed to support either an MPE-XL or HP-UX operating system is:

- One CS80 Disc Drive (HP 7935).
- One System Console (HP 2392A).
- One Mag Tape (HP 7978).
- One Line Printer (HP 2563/2566).

The maximum number of peripheral hardware devices allowed for system configuration of the MPE-XL or HP-UX operating system is listed in Table 3-2. For specific default device configuration information, refer to Tables 7-1 and 7-2 in Section 7.

Table 3-2. Maximum Peripheral Devices for System Configuration

Peripheral Device	Maximum Quantity (MPE-XL)	Maximum Quantity (HP-UX)
Devices allowed on HP-IB device adapter.	6	6
HPIB device adapter allowed on one channel adapter.	4	4
LAN cards allowed on channel adapter.	2	1
LAN cards allowed per system.	2	1
Disc spindles allowed on one HP-IB device adapter.	6	4
Disc spindles allowed per system.	24	8
Line printers allowed per system.	8	3
Page printers allowed per system.	4	-
Total printers allowed per system.	12	3
Tape drives allowed per system.	8	5
DTCs allowed per system.	16	n/a
Port muxes (6) allowed per system.	n/a	6
Channel adapter sets allowed per system.	3	1

#### Configuration

Table 3-3. System Card Cage Configuration

SLOT#	CARD CAGE	BOARD NAME
		CPU Card Cage
1 2 3 4 5 6	CPU CPU CPU CPU CPU CPU	Register File (RF) unit Floating Point Coprocessor (C1) Coprocessor (C2 – option w/MPE-XL Execution Unit (EU) Instruction Unit (IU) Translation Lookaside Buffer (TL) Unit Cache (CA) Unit
		Midbus Module
8 9 10 11 12 13	Memory Memory Memory Mrmory Memory Memory	Memory Array (MA) – 5Mb Memory Controller (MC) – 3Mb Memory Array (MA) – 5Mb Memory Controller (MC) – 3Mb Memory Array (MA) – 5Mb Memory Controller (MC) – 3Mb
*0-11 12 13	CIO CC CIO CC	- CIO Card Cage CIO Device Adapters (up to 12, maximum) Access Port (AP) Card CIO Buffer Card

Lower slot numbers have higher priority. Use these lower numbered slots for high speed peripheral devices.

LG200012\_005

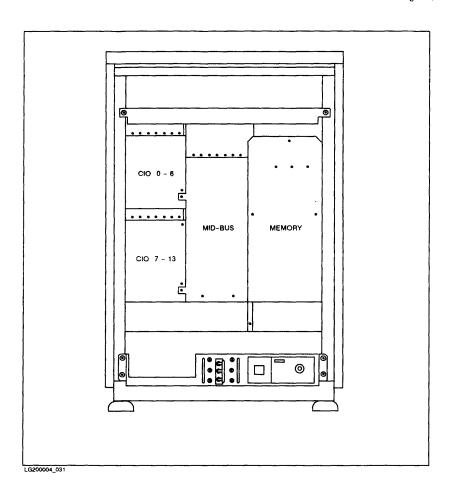


Figure 3-1. System Card Cage Location

#### **CPU Card Cage Configuration Assignment**

Each Central Processor Unit (CPU) Card has an assigned slot location in the CPU Card Cage. The CPU Card Cage is located between the power supplies (behind a cover plate), inside the front door of the computer cabinet. Refer to Table 3-3 for CPU card slot definitions.

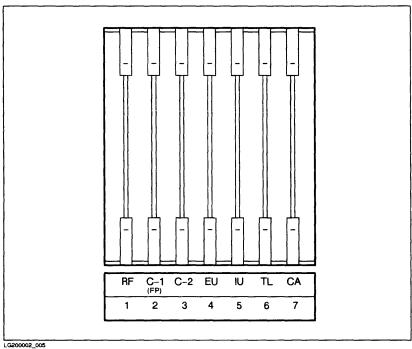


Figure 3-2. CPU Card Slot Assignments

#### **CIO Card Cage Configuration Assignment**

Each peripheral device in the system is connected to the computer through a Channel I/O (CIO) card, installed in the CIO Card Cage. The two CIO Card Cages (one upper and one lower) are located to the left of the Midbus (inside the rear door of the computer cabinet). (See Figure 3-1.)

A standard MPE-XL operating system includes two channel adapters, with a third channel adapter available as an option. The standard HP-UX operating system consists of one channel adapter. The CIO service priority system is the same for each channel adapter: the service priority of a particular device adapter is determined exclusively by its CIO slot assignment.

#### REQUIRED CARDS AND CIO SLOTS

- CIO slot #13, CIO Buffer Card

MPE-XL
- CIO slot #0, HP-IB for the System Disc
- CIO slot #1, MUX (6 port) for the System Console
- CIO slot #2, HP-IB for the Mag Tape and Printer
- CIO slot #12, Access Port Device Adapter
- CIO slot #12, Access Port Device Adapter

- CIO slot #13, first CIO Buffer Card

- Expansion Bay CIO slot #B1, second CIO Buffer Card

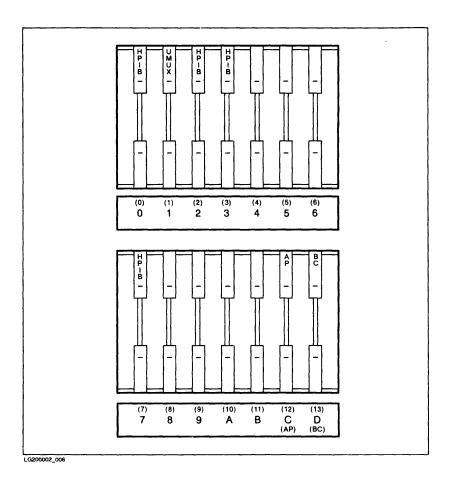


Figure 3-3. Channel I/O Card Slot Assignments

# **Memory Card Cage Configuration Assignment**

Memory configuration consists of combinations of 3 Mbyte Memory Controller (MC) Cards and 5 Mbyte Memory Array (MA) Cards. All are installed in the Memory Card Cage, located to the right of the Midbus, inside the rear door of the computer cabinet. (See Figure 3-1 for card cage location and Figure 3-4 for slot assignments.)

Support of the MPE-XL System Software:

- Minimum memory required is 16 Mbytes.
- Maximum memory allowed is 24 Mbytes.

Support of the HP-UX System Software:

- · Minimum memory required is 8 Mbytes.
- Maximum memory allowed is 24 Mbytes.

NOTE

Supported memory configurations are 8, 16, and 24 Mbytes, only.

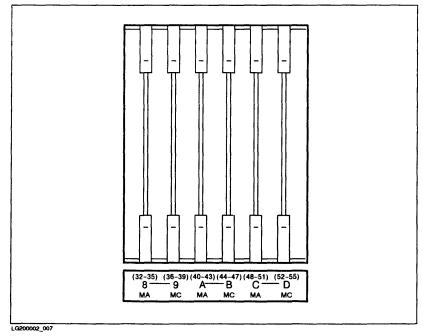


Figure 3-4. Memory Array and Memory Controller Slot Assignments

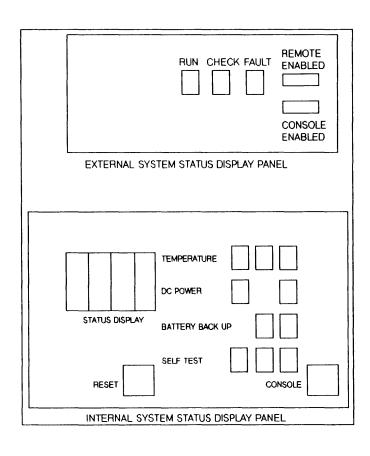
# **TROUBLESHOOTING**

SECTION

4

This section contains troubleshooting data that is designed to assist the CE with repair and diagnostic functions associated with the HP 3000/930 and 9000/840 Computer Systems.

System Display Status Codes .																	 . 4-8
SPU TROUBLESHOOTING																	 4-11
Troubleshooting Procedures	١																 4-11
DC Power Supply Check								 									 4-11
Power Supply Troubleshooting				٠.									 				 4-12
Selftest Switch Settings																	 4-13
Selftest as a Troubleshootin	g T	'ool															 4-20



Tables 4-1 and 4-2 provide LED status information to be used as an aid for troubleshooting.

NOTE

Figure 4-1. System Status Display Panels

Table 4-1. External System Control Panel

Indicator	Status
RUN (LED is Green)	All of the following:
	<ul> <li>Selftest passed.</li> <li>ISL Program Module (OS, DIAG, or UTIL) is loaded.</li> </ul>
	• Power supplies are within voltage specification.
	<ul> <li>Battery backup is charged.</li> </ul>
	• Temperature is normal.
CHECK (LED is Yellow)	One or more of the following:
	• Selftest in progress.
	• Initialization in progress.
	• Software initiated shutdown.
	Non-fatal error has occurred in selftest.
	Battery backup is charging.
	System temperature is marginal.
FAULT (LED is Red)	One or more of the following:
	• Fatal error.
	• One or more power supplies out of voltage spec.
	Battery backup in use.
	Overtemp. System about to shutdown.
REMOTE ENABLED (On)	System "open" to remote access.
TEMOTE EMBELD (OII)	(AP Link enabled.)
CONSOLE ENABLED (On)	System "open" to System Console access. See CONSOLE
	button on Internal Control Panel.
	(Mechanical Enable.)

## NOTE

The red FAULT LED on the External Display will light whenever any red LED on the Internal Display is lighted. The yellow CHECK LED on the External Display lights whenever the a yellow LED on the Internal Display is lighted. The green RUN LED on the External Display will light when all green LEDs on the Internal Display are lighted. The one exception is that during battery backup, the green RUN LED and the yellow CHECK LED will light simultaneously as the battery is charging. At system shutdown, all lights are OFF.

Table 4-2. Internal System Control Panel

Indicator	Status
TEMPERATURE	Green - Temperature within normal specification.
	Yellow - System temperature is marginal.
	Red - Overtemp. System shutdown.
DC POWER	Green - Power supplies within normal voltage specification.
	Red - One or more power supplies out of voltage specification.
BATTERY BACKUP	Yellow - Battery backup is charging.
	Red - Battery backup in use.
SELF TEST	Green - Selftest passed.
	Yellow - Selftest in progress.
	- Non-fatal error has occurred in Selftest.
	<ul> <li>Initialization is in progress.</li> <li>Software initiated shutdown.</li> </ul>
	Red - Fatal error.
L	

TEMPERATURE							
DC POWER							
CONFIGURATIO	1/16 DN 2/8	- [] - []					
EXPANSION BAY INTERNAL DISPLAY PANEL							
EXP 1 EXP 2	RUN	CHECK	FAULT				
EXPANSI	ON BAY EX	TERNAL DISF	PLAY PANEL	, , , , , , , , , , , , , , , , , , , ,			

Tables 4-3 and 4-4 provide indicator/status information for the Expansion Bay Module internal/external system status display panels.

NOTE

Figure 4-2. Expansion Bay Module System Status Display Panels

Table 4-3. Expansion Module Internal Display Panel

Indicator	Status
TEMPERATURE	Green LED - System temperature is normal.  Yellow LED - System temperature is marginal.  Red LED - Overtemp. System shutdown.
DC POWER	Green LED - System temperature is normal.  Red LED - Overtemp. System shutdown (either manually or automatically).  - DC Power out of spec.
CONFIGURATION	1/16 (Green LED) - System Monitor/Configuration Card inserted (Slot A2). 2/8 (Split Green LED) - System Monitor/Configuration Card inserted (Slot A1).

# NOTE

The System Monitor/Configuration Card inserted in Slot A2 defines the backplane as being a single 16-slot bus; the System Monitor/Configuration Card inserted in Slot A1 defines the backplane as being two, mutually independent 8-slot busses.

Table 4-4. Expansion Module External Display Panel

Indicator	Status
RUN (Green LED) (EXP 1 and EXP 2)	<ul> <li>Power supply voltages within normal specification.</li> <li>Temperature inside module is normal.</li> </ul>
CHECK (Yellow LED) (EXP 1 and EXP 2)	• Temperature inside module is high.
FAULT (Red LED) (EXP 1 and EXP 2)	Overtemp. System shutdown (either manually or automatically).
	• One or more power supplies not within normal voltage specification.

## NOTE

The External Display Panel is split in two horizontally, providing status indications for a single installed Expansion Module (EXP 1) and also for a second module (EXP 2), as applicable. The row of indicators associated with EXP 2 will remain off at all times if the second module is not present in the cabinet.

# SYSTEM DISPLAY STATUS CODES

Tables 4-5 and 4-6 provide the detailed format of the hexadecimal display panel shown in Figure 4-3. High Priority Machine Checks may be associated with any of these class errors. For detailed descriptions on all error numbers generated by selftest, PDC/IODC, and ISL refer to Chapter 8 of the Hardware Support Manual, P/N 09740-90011.

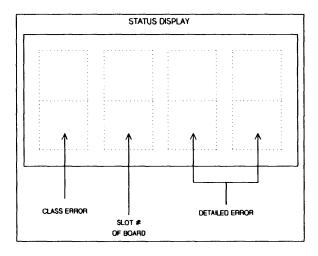


Figure 4-3. Hexadecimal Display Panel

Table 4-5. Class Error Descriptions

Class Errors	Description of Error Condition
0	Catastophic Failure.
1	Processor Hardware Failure.
2	Cache (CA+) or Translation Lookaside Buffer (TLB) Hardware Failure.
3	Processor Dependent Hardware/System Monitor Failure.
4	Coprocessor Hardware Failure.
5	Bus Protocol Error.
6	Reserved.
7	Memory Hardware Failure.
8	I/O Hardware Failure.
9	Console Device Failure.
A	Boot Device Failure.
В	Operating System Software.
С	Initialization Failure.
Е	OS or Environmental Warning.
F	Run Time Messages.

Table 4-6. Seiftest Error Codes

Class Error#	Slot # with Detailed Error	Description	Action
1	1 <u>1</u> XX	Processor Failure - RF Unit.	Replace Faulty Board.
1	14XX	Processor Failure - E Unit.	Replace Faulty Board.
1	1 <u>5</u> XX	Processor Failure - I Unit.	Replace Faulty Board.
2	26FF	TLB/CA Failure - TLB Unit.	Replace Faulty Board.
2	27 <b>XX</b>	TLB/CA Failure - Cache Board.	Replace Faulty Board.
3	3 <u>0</u> XX	Processor Dependent Hardware Failure (System Monitor Card Failure 30).	Replace Faulty Board.
4	4ZXX*	Coprocessor Failure.	Replace Faulty Board.
5	5ZXX*	Bus Protocol Failure.	Replace Faulty Board.
6	6XXX*	Architecturally Reserved.	Replace Faulty Board.
7	7 <b>Z</b> XX*	Memory Hardware Failure.	Replace Faulty Board.
8	8ZXX*	I/O Channel Adapter Test.	Replace Faulty Board.
	XXF0-XXFF	HPMC (See detailed error messages in Chapter 11 of Hardware Support Manual, P/N 09740-90011.)	Replace Faulty Board.
9	9ZXX*	Console Device Path Test.	Replace Faulty Board.
A	AZXX*	Boot Device Path Test.	Replace Faulty Board.
В	BZXX*	Operating System Failure.	Replace Faulty Board.
С	$\overline{CA}XX$	Initialization: Power Fail.	Replace Faulty Board.
C C	$\overline{CBXX}$	Initialization: Transfer of Control.	Replace Faulty Board.
С	CEXX	Initialization: Initial System Load Code.	Replace Faulty Board
	0 <u>5</u> XX	Loader Error: Parallel Card.	Replace Faulty Board

<sup>\*</sup> Z = Slot dependent value.

NOTE

The detailed error code is reflected by the last two digits on the System Display Panel. Detailed error descriptions are provided in Chapter 8 of the Hardware Support Manual, P/N 09740-90011.

## SPU TROUBLESHOOTING

The repair strategy of the System Processing Unit (SPU) is to identify and replace any failed Field Replaceable Unit (FRU). In most cases the FRU will be a Printed Circuit Assembly (PCA).

## **Troubleshooting Procedures**

Observe for proper operation of the following SPU hardware, firmware, and software elements:

- AC and DC power supply and distribution.
- Selftest operation.
- Access port operation.
- Initial System Load (ISL) prompt appearance.
- · Operating System boot.
- Online diagnostic subsystem operation.

When a malfunction is encountered, replace the assembly indicated in the test procedures and SPU Internal Control Panel selftest code legend. Refer to Chapter 8 in the Hardware Support Manual, P/N 09740-90011 for additional information.

Computer malfunctions can be isolated to the assembly level by performing the following tests:

- DC power supply check.
- Selftest. (Refer to Table 4-6 and Section 5. For additional information, refer to Chapter 8 in the Hardware Support Manual, P/N 09740-90011.)
- Diagnostics (refer to Section 5 or the Online Diagnostics Subsystem Manual, P/N 09740-90020 for more detailed information).

# **DC Power Supply Check**

Verify the power supply voltages by performing the following procedure. The voltage checks must be made with all plug-in cards installed in the computer.

## WARNING

Hazardous voltages are present. Observe all warning labels on equipment to ensure safety of personnel. All maintenance/repair work must be done by qualified personnel.

The following is a procedure for checking power supply voltages:

- 1. Verify that the Main Power Breaker is OFF.
- Connect power cord to a power outlet having the electrical characteristics specified on the rear of the computer.
- 3. Turn the Main Power Breaker to ON.
- Verify that voltages and signals at the test points on System Monitor Module are as listed in Table 4-7 by using a digital voltmeter.
- Replace power supply if the computer does not pass the DC Power Supply Check. Refer to Section 6 or the Hardware Support Manual, P/N 09740-90011, for removal/replacement procedures.

## POWER SUPPLY TROUBLESHOOTING

Power supply troubleshooting consists of removal and replacement. The two procedures (one for Power Supply #1 and another for Power Supply #2 and #3) are found in Section 6.

Power supply and distribution problems that do occur can be checked for proper operation by following the Troubleshooting Flowcharts (see Figures 4-4 thru 4-9).

Table 4-7. Power Supply Test Points

Voltage Status	Test Point Color (Qty)	Test Signal	DC Voltage Specification
Power Supply	Yellow (5 ea.)	PON 1, PON 2, PON 3 MB. PFW, MB. PON	2. 4V min. (logic 1) 2. 4V min. (logic 1)
Lithium Battery	Red (2 ea.)	+3V1, +3V2	2. SV minimum
Power Supplies (3)	Red (9 ea.)	-12V PS1, -12V PS3 +12V PS1, +12V PS3 +28V PS2, +28V PS3 +5V PS1, +5V PS2, +5V PS3	-10. 56V to -13.44V 10. 80V to 13.20V 22. 4V to 33. 6V 4. 8V to 5. 25V
Internal Battery	Red (1 ea.)	+10V BATT	8. 4V to 11.90V
Secondary Power (Mid-bus slots)	Red (2 ea.)	+5VS1, +5VS2	4.8V to 5.25V
Ground	Black (1 ea.)	Ground	

NOTE

The above power supply test points are located on the System Monitor Card.

# **Selftest Switch Settings**

Eight Dip switches located on the front of the System Monitor Module (refer to Diagrams, Section 9) control the execution of selftest. Normal position for all switches is the CLOSED position.

Table 4-8. Selftest Switch Settings

SWITCH NUMBER	CLOSED POSITION	OPEN POSITION					
1	Normal	Toggle switch to bypass error and execute the remainder of selftest; to boot system.					
2	Normal	Continuous loop on selftest.					
3	Normal	Soft Reset or Transfer of Control (TOC).					
4	Normal	Detect single bit errors on memory.					
5	Normal	Selftest will continue on nonfatal errors. Bypass I/O errors					
6	Normal	Reserved for future use.					
7	Normal	Displays test sequence flow on the System Console.					
8	Normal	Reserved for future use.					

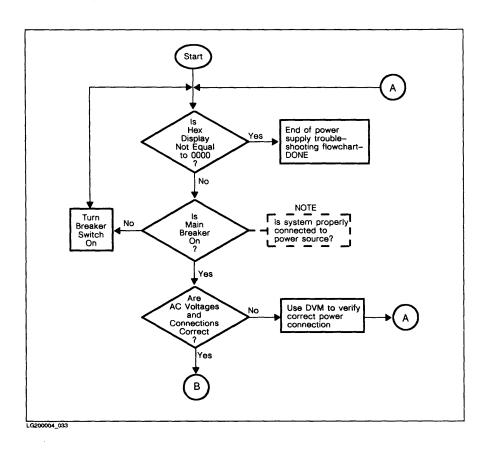


Figure 4-4. Power System Troubleshooting Flowchart 1

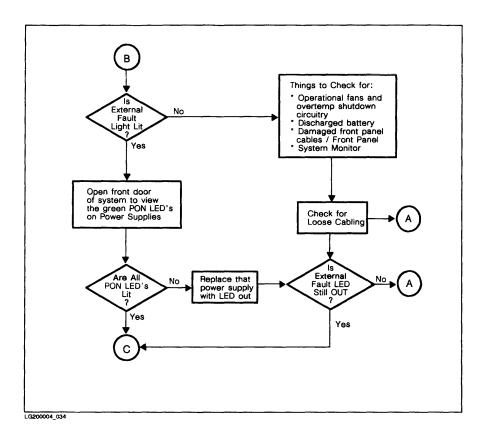


Figure 4-5. Power System Troubleshooting Flowchart 2

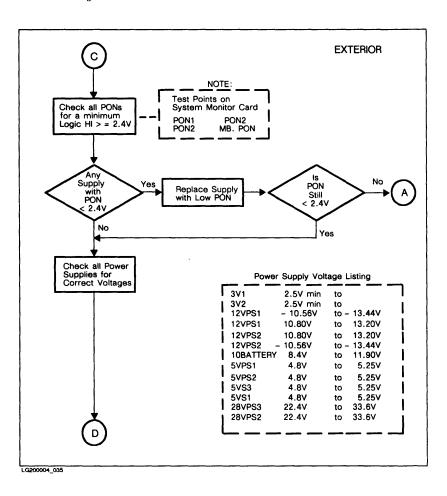


Figure 4-6. Power System Troubleshooting Flowchart 3

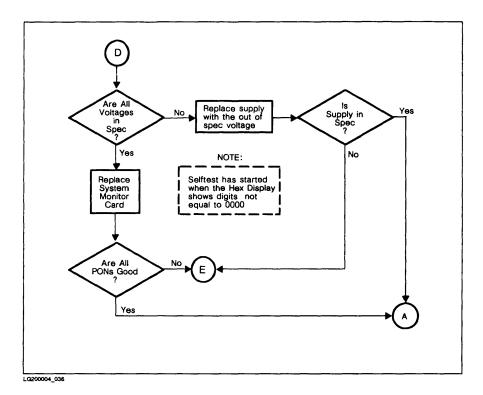


Figure 4-7. Power System Troubleshooting Flowchart 4

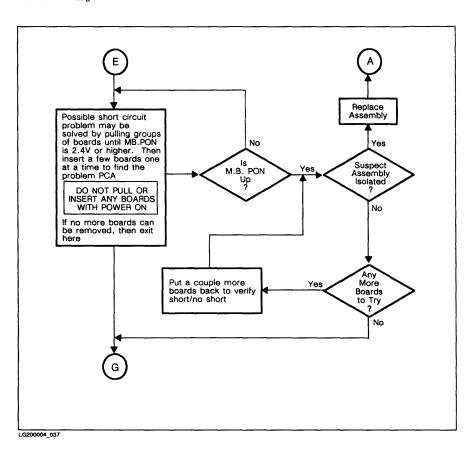
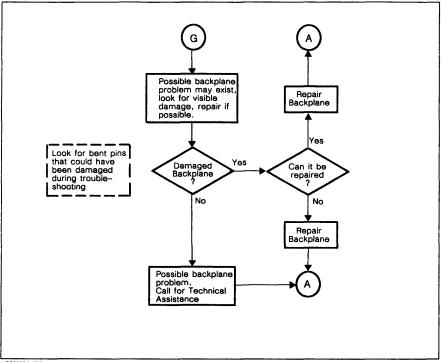


Figure 4-8. Power System Troubleshooting Flowchart 5



LG200004\_038

Figure 4-9. Power System Troubleshooting Flowchart 6

# Selftest as a Troubleshooting Tool

The following flowcharts (Figures 4-10 thru 4-16) illustrate how to use Selftest as a troubleshooting tool.

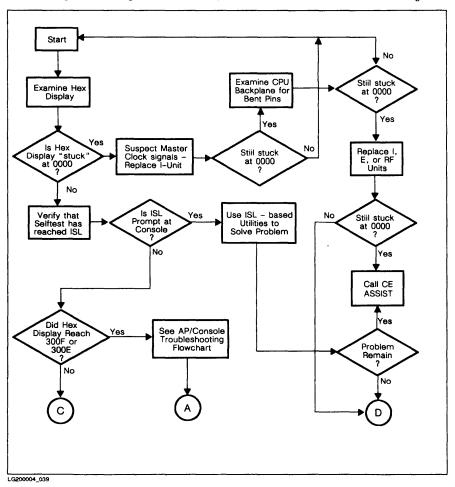


Figure 4-10. Selftest Operation Flowchart 1

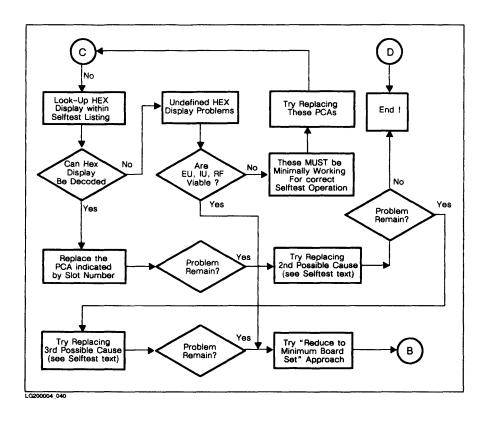


Figure 4-11. Selftest Operation Flowchart 2

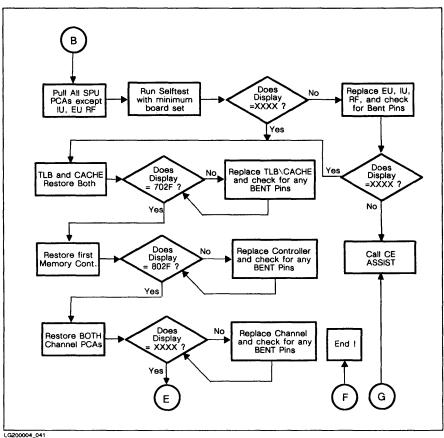


Figure 4-12. Selftest Operation Flowchart 3

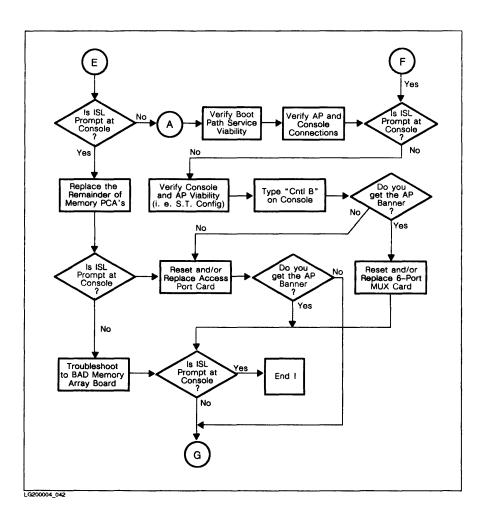


Figure 4-13. Selftest Operation Flowchart 4

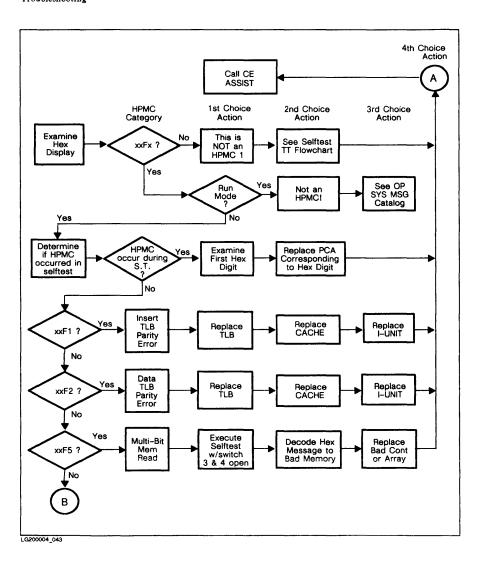


Figure 4-14. Selftest Operation Flowchart 5

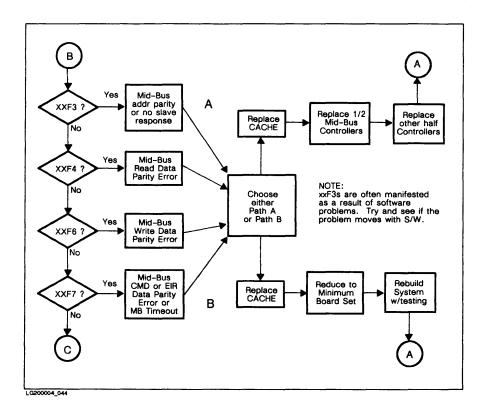


Figure 4-15. Selftest Operation Flowchart 6

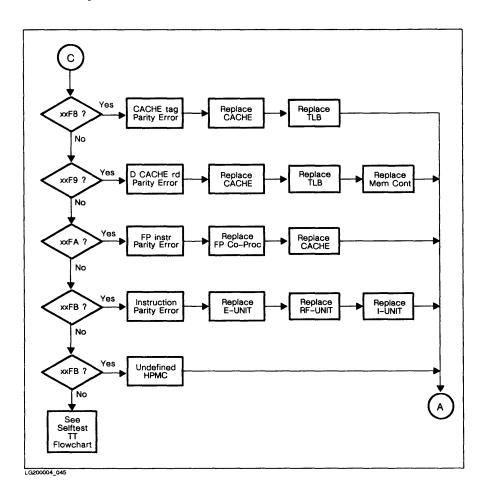


Figure 4-16. Selftest Operation Flowchart 7

# **DIAGNOSTICS**

SECTION

The Diagnostics Section provides information pertaining to the supported diagnostics and utilities for MPE-XL and HP-UX operating systems.

HP 9740A SPU SELFTEST
Selftest Display 5-
Diagnostic/Utility Orientation
Diagnostic User Interface (DUI)
CS/80 Disc Diagnostic (CS80DIAG)
HP 7974A and 7978A/B Magnetic Tape Drive Diagnostic (DIAG7478)5-
Ciper Line Printer Diagnostic (CIPERLPD)
HP-IB Device Adapter Diagnostic (HPIBDIAG)
Memory Array Diagnostic (MEMDIAG)
Asynchronous Six-Channel Multiplexer Diagnostic (MUXDIAG)
Local Area Network Device Adapter Diagnostic (LANDAD)
I/O Test Tool (IOTT)
HP-CIO Channel Adapter Utility (CADIAG)
System and Memory Log Analysis Tool (LOGTOOL)
System Map (SYSMAP)
HP-UX Logging Facility
MPE-XL Online Diagnostic Installer
MPE-XL Online Diagnostic Implementation
Implementation Dependent Information
MPE-XL Specific Diagnostic Procedures/Features5-2
HP-UX Online Diagnostic Implementation
Implementation Dependent Information
HP-UX Specific Diagnostic Procedures/Features

### Diagnostics

### **HP 9740A SPU SELFTEST**

The HP 9740A SPU Selftest is responsible for initializing and testing the IU, EU, RF, TLB, CA boards, all installed memory controller and memory array boards, and I/O cards that have built in selftest code. It checks data paths and component functionality for all boards in the SPU processor.

Selftest code can be invoked in the following ways:

- Cold Power On (PON).
- External Reset (ER).
- · High Priority Machine Check (HPMC).
- Return from Power Fail (Powerfail Recovery).
- Transfer of Control/Soft Reset (TOC/SRS).

Refer to Online Diagnostics Subsystem Manual, P/N 09740-90020, for detailed descriptions and procedures.

## **Selftest Display**

The two types of display messages used for Selftest are displayed on a four digit hexadecimal display window located inside the front cabinet door (Refer to Section 4, Figure 4-4) and on the System Console. These display messages are:

- ERROR/WARNING MESSAGES Indicates failure in one of the defined Classes, directs user to slot number of the Field Replaceable Unit (FRU), and provides detailed information about the cause of error
  - 300F is displayed at successful completion of selftest.
  - 300E is displayed at successful completion of selftest with warning.
  - 0000 is displayed to indicate a catastrophic error at an entry point in the execution of selftest.
- INFORMATIONAL/RUN TIME MESSAGES Indicates what the selftest is doing at any given time. On Informational displays, the detailed error numbers are set to zero.

For detailed descriptions of error messages, refer to Chapter 8 of the Hardware Support Manual, P/N 09740-90011.

## DIAGNOSTIC/UTILITY ORIENTATION

The Online Subsystem Operating Software is the Diagnostic User Interface (DUI) that provides access to the following diagnostic programs:

- CS/80 Disc Diagnostic (CS80DIAG).
- HP 7974A/7978A Magnetic Tape Diagnostic (DIAG 7478).
- CIPER Line Printer Diagnostic (CIPERLPD).
- HPIB Device Adapter Diagnostic (HPIBDIAG).
- Memory Array Diagnostic (MEMDIAG).
- Asynchronous Six-Channel Multiplexer Diagnostic (MUXDIAG).
- Local Area Network Device Adapter Diagnostic (LANDAD).
- ALINK Diagnostics (ALDIAG).
- Eagle Diagnostic (EGLDIAG).
- Page Printer Diagnostic (PPDIAG).

### The following are the supported Utilities:

- I/O Test Tool (IOTT).
- HP-CIO Channel Adapter Diagnostic Utility (CADIAG).
- System and Memory Log Analysis Tool (LOGTOOL).
- System Map (SYSMAP).
- HP-UX Logging Facility (DECODE and DELOG).
- MPE-XL Online Diagnostic Installer.

# The Diagnostic and Utility Subsystems are designed for:

- MPE-XL Diagnostic Implementation.
- HP-UX Online Diagnostic Implementation.

# Diagnostics

Table 5-1. Supported Diagnostic Programs

DIAGNOSTIC NAME	DESCRIPTION	MPE-XL	HP-UX
CS80DIAG	CS/80 Disc Diagnostic	Yes	Yes
DIAG7478	HP 7974A/7978A/B Magnetic Tape Diagnostic	Yes	Yes
CIPERLPD	CIPER Line Printer Diagnostic	Yes	Yes
PPDIAG	Page Printer Diagnostic	Yes	No
HPIBDIAG	HPIB Device Adapter Diagnostic	Yes	Yes
MEMDIAG	Memory Array Diagnostic	No	Yes
MUXDIAG	Asynchronous Six-Channel Multiplexer Diagnostic	No	Yes
LANDAD	Local Area Network Device Adapter Diagnostic	Yes	Yes

Table 5-2. Supported Subsystem Utilities

UTILITY NAME	DESCRIPTION	MPE-XL	HP-UX
ЮТТ	I/O Test Tool	Yes	No
CADIAG	HP-CIO Channel Adapter Utility	Yes	No
LOGTOOL	System and Memory Log Analysis Tool	Yes	No
DECODE	HP-UX Logging Facility	No	Yes
DELOG	HP-UX Logging Facility	No	Yes
MEMLOGP	Memory Error Logging Process	Yes	No
SYSMAP	System Map	Yes	No
INSTALL	MPE-XL Online Diagnostic Installer	Yes	No

# Diagnostic User Interface (DUI)

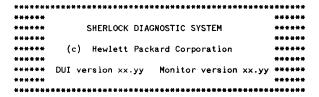
The Diagnostic User Interface (DUI) provides access to all programs in the Online Diagnostic System.

## Mini-Operating Instructions

1. Enter the following system command to the system prompt:

:SYSDIAG

The diagnostic will respond with the following header and welcome message indicating that access has been gained to the Online Diagnostic System:



Type "HELP" for assistance.

There is no Monitor version appearing on HP-UX systems. On HP-UX systems a positive integer will appear as part of the DUI prompt to represent how many commands have been entered into the current DUI session.

## Diagnostics

2. Enter HELP to the DUI prompt for the following list of available commands to appear:

#### DUI > HELP

0011111110	DECORTORION
COMMAND	DESCRIPTION
ABORT	Terminates active diagnostic programs.
CI or !	Provide access to operating system interpreter (shell).
EXIT	Exit from the diagnostic system.
HARDCOPY	Echo information displayed on terminal to printer or file.
HELP or ?	Provide help information for DUI or diagnostic programs.
INSTALL	Add/update programs in the diagnostic system.
LIST	List the programs that are part of the diagnostic system.
MODE	Display/change current system mode.
PURGE	Delete programs from the diagnostic system.
REDO or ^	Display and edit last DUI command.
RESUME	Allow a suspended program to resume processing.
RUN	Execute the specified program.
SHOWACTIVE	Display programs running in diagnostic system.
SUSPEND	Suspend the processing of the specified program.
USE	Causes DUI commands to be read from a file.
WAIT	Wait for background programs to terminate.

# 3. To exit the DUI, type EXIT.

For a list of possible error messages which may appear when using the DUI, refer to Section 2 in the Online Diagnostics Subsystem Manual, P/N 09740-90020.

# CS/80 Disc Diagnostic (CS80DIAG)

The CS/80 Disc Diagnostic (CS80DIAG) will test HP 7908/11/12/14 or HP 7933/35/37 disc drives. This diagnostic can detect failures of one or more Field Replaceable Unit (FRU).

## Mini-Operating Instructions

1. Enter the following to the system prompt:

:SYSDIAG

2. Enter the following to the DUI prompt:

DUI > RUN CS80DIAG < RUN Command Options >

Typing HELP will cause a summary of the DUI function and its commands to appear on the screen. Refer to the DUI section in the Online Diagnostics Subsystem Manual, P/N 09740-90020, for details concerning the RUN command options.

3. The diagnostic responds with a header and welcome message.

If sections and steps to be run are not specified, the default sections and steps will be executed. The default sections are Sections 2, 3, 4, 5, 8, and 9. Default steps are all steps within sections. Execution of these defaults is dependent on the test mode that has been granted by the system.

#### **DEFAULT SECTIONS**

- o Section 2 Clear
- o Section 3 Identify
- o Section 4 Loopback (all steps)
- o Section 5 Selftest
- o Section 8 Common System Operations (all steps)
- o Section 9 Status Tests (all steps)

-----

o Section 17 - CS/80 External Exerciser (Interactive Section)

#### ADDITIONAL SECTIONS AVAILABLE

- o Section 6 Status
- o Section 7 Error Logs

## Diagnostics

If Section 17 is selected, the CS/80 diagnostic prompt will appear.

#### CS80DIAG>

Entering HELP to the prompt will display a list of the available CS/80 External Exerciser commands.

CS80DIAG > HELP

ADDRESS Converts block addresses to 3-vector and visa versa. CANCEL Tells the device to cancel the provious command. CICLEAR Issues a CS/80 Channel Independent Clear on the disc. CLEAR LOGS Clears the various error logs on the device. DESCRIBE Obtains describe information from the device. DIAG Provides access to device's internal diagnostics. **ERRSUM** Obtains an error summary from the device. ERT LOG Provides access to the device's ERT data error log. EXIT Terminates execution of the External Exerciser.

FAULT LOG Provides access to the device's fault log.

HELP Provides this list of commands as well as more detailed

descriptions and syntax of each command.

INIT MEDIA Initializes the device's media.

READ Reads and displays a block of data from the device. REV Provides access to the revision data for the device. RFSECTOR Reads and displays a full sector of data from the disc,

including header and trailer information.

RO ERT Performs a read-only error rate test on the device.

RUN LOG Reads the device's run-time data error log.

SDCLEAR Performs a CS/80 Selected Device Clear on the device. SENSE Reads data from the device's environmental sensors.

SET PATTERN Set pattern to be used in error rate tests.

SET RPS Sets/resets the Rotational Position Sensing feature on the

device.

Spares a block of data on the device. SPARE

SUSPEND Suspends CS80DIAG and returns control to the DUI. **TABLES** Provides access to the various tables on the device. UNIT

Sets the unit number on the device.

WTR FRT Performs a write-then-read error rate test on the device.

5. Type EXIT to exit Section 17 and control will return to the Online Diagnostic System.

End of Section 17 - External Exerciser

For a list of error messages which may appear when using CS80DIAG, refer to the Online Diagnostics Subsystem Manual, P/N 09740-90020.

# HP 7974A and 7978A/B Magnetic Tape Drive Diagnostic (DIAG7478)

The HP 7974A and 7978A/B Magnetic Tape Drive Diagnostic (DIAG7478) will test an HP 7974A or HP 7978A/B Magnetic Tape Drive online and offline. Specify which sections and steps are to be run.

### Mini-Operating Instructions

- Ensure the tape drive to be tested is powered on. Ensure that a scratch tape has been mounted and
  the tape drive is placed online for sections which tape movement and write/read operations are to
  be run.
- 2. Enter the following command to the system prompt:

:SYSDIAG

3. Enter the following command to the DUI prompt:

DUI > RUN DIAG7478 < RUN Command Options>

Type HELP for a summary of the available RUN commands. Refer to the DUI section in the Online Diagnostics Subsystem Manual, P/N 09740-90020, for details.

4. The diagnostic responds with a header and welcome message.

If specific sections and steps are not specified, the following default sections and steps will be executed:

## **DEFAULT SECTIONS**

- o Section 2 Clear
- o Section 3 Identify
- o Section 4 Loopback
- o Section 6 Hardware Status
- o Section 50 Image Utilities
- o Section 55 Display Logs

#### For the HP 7974A Only:

o Section 34 - HP 7974A Selftests

#### For the HP 7978A/B Only:

- o Section 38 HP7978A/B Selftests
- o Section 40 Firmware Update Utilities
- o Section 50 Image Dump Utilities
- o Section 55 Internal Device Logs

## ADDITIONAL SECTIONS AVAILABLE

- o Section 7 Downloading Selftests
- o Section 10 Set Tape Density Commands
- o Section 15 Write/Read Comparison Check (NRZI or GCR)
- o Section 16 Write/Read Comparison Check (PE)
- o Section 20 Selectable Tape Movement Commands
- o Section 23 Selectable Tape Read Data Commands

## Diagnostics

- o Section 25 Paces
- o Section 45 Download Diagnostics
- o Section 60 Interactive Section
- o Section 62 Do All Tests

NOTE

For MPE-XL, the default magtape LDEV parameter is 7. For HP-UX, no default magtape device parameter exists.

 Type EXIT and control will return to the Online Diagnostic System as soon as all requested steps are complete.

For a list of error messages that may appear when using DIAG7478, refer to Section 4 in the Online Diagnostics Subsystem Manual, P/N 09740-90020.

## Ciper Line Printer Diagnostic (CIPERLPD)

The Control messages for Intelligent Peripherals (CIPER) Diagnostic will test an HP 2563A or HP 2565A/66A Line Printer to detect failures of a Field Replaceable Unit (FRU). The CE can:

- Specify which sections and steps are to be run.
- · Set test parameters to control the handling of error messages.
- Select the number of test executions and the particular CIPER Line Printer unit to be tested.

#### Mini-Operating Instructions

1. Enter the following command to the system prompt:

+SYSDTAG

2. Enter the following command to the DUI prompt:

DUI > RUN CIPERLPD < RUN Command Options>

Enter HELP to display a summary of the available RUN commands. Refer to the DUI section in the Online Diagnostics Subsystem Manual, P/N 09740-90020, for details.

3. The diagnostic responds with a header and welcome message.

If specific sections and steps are not specified, the following default sections and steps will be executed:

### NOTE

The CIPER device to be tested must be powered up and put online to ensure proper completion of all sections and steps.

#### DEFAULT SECTIONS

- o Section 2 Reset
- o Section 3 Clear/Identify
- o Section 5 Selftest
- o Section 6 Request Device Status (all steps)

## ADDITIONAL SECTIONS AVAILABLE

- o Section 10 Ripple Print
- o Section 12 Request and Decode Environmental Status
- o Section 14 Request and Decode Job Status
- To exit CIPERLPD, type EXIT and control will return to the DUI upon completion of the current section and step.

For a list of error messages which may appear using CIPERLPD, refer to Section 5 in the Online Diagnostics Subsystem Manual, P/N 09740-90020.

## HP-IB Device Adapter Diagnostic (HPIBDIAG)

The HP-IB Device Adapter Diagnostic (HPIBDIAG) is a diagnostic system program that provides the capability to test online the functionality of the HP-IB Device Adapter, which is itself a Field Replaceable Unit (FRU).

### Mini-Operating Instructions

. Enter the following command to the system prompt:

:SYSDIAG

2. Enter the following command to the DUI prompt:

DUI> RUN HPIBDIAG < RUN Command Options>

Refer to the DUI section in the Online Diagnostics Subsystem Manual, P/N 09740-90020, for details concerning the RUN command options.

3. The diagnostic responds with a header and welcome message.

If specific sections and steps are not specified, the default sections and steps will be executed based on the following diagnostic system modes:

#### DEFAULT SECTIONS

- o Section 3 Identify
- o Section 4 Loopback
- o Section 5 Selftest

#### ADDITIONAL SECTIONS AVAILABLE

- o Section 6 Status
- o Section 12 Rollcall

4. To exit HPIBDIAG type EXIT. Control will return to the Online Diagnostic System.

For a list of error messages that may appear when using HPIBDIAG refer to Section 6 in the Online Diagnostics Subsystem Manual, P/N 09740-90020.

# Memory Array Diagnostic (MEMDIAG)

The Memory Array Diagnostic (MEMDIAG) tests and verifies the memory controllers and memory arrays online from the System Console or a remote maintenance terminal.

The Memory Array Diagnostic provides four diagnostic functions and one verifier function. The diagnostic functions consist of a total pattern test of memory, a quick pattern test of memory, and a manual test select.

#### Mini-Operating Instructions

1. Enter the following commands:

:SYSDIAG

2. DUI > RUN MEMDIAG < RUN Command Options>

Refer to the DUI section in the Online Diagnostics Subsystem Manual, P/N 09740-90020, for details concerning the RUN command options.

3. The diagnostic responds with a header and welcome message.

If specific sections and steps are not specified, the following default sections and steps are executed based on the diagnostic mode which has been selected by the Online subsystem. Refer to the Online Overview discussion of diagnostic modes in the Online Diagnostics Subsystem Manual, P/N 09740-90020, for details.

## SECTIONS AVAILABLE

- o Section 10 Full Automatic Memory Test (all steps)
- o Section 11 Partial Automatic Memory Test (all steps)
- o Section 12 Error Detection and Correction Memory Test (all steps)
- o Section 13 User Interactive Testing (all steps)
- o Section 14 Verifier/Sweep Functions (all steps)
- 4. To exit MEMDIAG type EXIT. Control will return to the Online Diagnostic System.

For a list of error messages that may appear when using MEMDIAG, refer to Section 7 in the Online Diagnostics Subsystem Manual, 09740-90020.

# Asynchronous Six-Channel Multiplexer Diagnostic (MUXDIAG)

The Asynchronous Six-Channel Multiplexer Diagnostic (MUXDIAG) is a diagnostic subsystem program that checks the functionality of the HP 27140A Asynchronous Six-Channel Multiplexer Interface card, which is itself a Field Replaceable Unit (FRU).

### Mini-Operating Instructions

1. Enter the following commands:

:SYSDIAG
DUI> RUN MUXDIAG <RUN Command Options>

Typing HELP to the prompt will display a summary of the available RUN commands. Refer to Section 8 in the Online Diagnostics Subsystem Manual, P/N 09740-90020, for details concerning these RUN command options.

2. The diagnostic will respond with a header and welcome message.

If specific sections and steps are not specified, the default sections and steps will be executed based on the following diagnostic system modes:

#### DEFAULT SECTIONS

- o Section 1 State
- o Section 3 Identify
- o Section 4 Loopback

#### ADDITIONAL SECTIONS AVAILABLE

- o Section 2 Clear
- o Section 5 Selftest
- o Section 10 Write/Read
- 3. To exit MUXDIAG type EXIT.

For a list of explanations of error messages that may be generated by MUXDIAG, refer to Section 8 in the Online Diagnostics Subsystem Manual, P/N 09740-90020.

## Local Area Network Device Adapter Diagnostic (LANDAD)

The Local Area Network Device Adapter Diagnostic (LANDAD) tests HP 36921A LAN Links (used on HP 3000/930 Computer Systems) and HP 98194A LAN Links (used on HP 9000/840 Computer Systems). LANDAD is capable of detecting a failure in one or more Field Replaceable Unit (FRU). (An FRU for LANDAD is the LAN interface card (LANIC), the LANIC connector cable, the attachment unit interface (AUI) cable, the medium attachment unit (MAU), and the medium interface (MDI).

#### Mini-Operating Instructions

Refer to the Online Diagnostics Subsystem Manual, P/N 09740-90020, for detailed explanations for running the diagnostics below.

Enter the following command to the system prompt.

:SYSDIAG



#### SYSDIAG 1> RUN LANDAD PDEV=8.4

(where PDEV is the physical device number. The first digit is the Midbus number (usually 8) and the second digit is the CIB slot number in which LANIC is located.)

3. The diagnostic responds with a header and welcome message.

The diagnostic will request a routine which allocates the LANIC and displays the following sections which can be run:

## **DEFAULT SECTIONS**

- o Section 3 Identify
- o Section 4 Local Loopback (to LANIC and back)
- o Section 6 Status

#### ADDITIONAL SECTIONS AVAILABLE

- o Section 1 More Help
- o Section 2 Reset
- o Section 5 Selftest
- o Section 7 Link Statistics
- o Section 8 External Loopback
- o Section 9 Remote Node Test
- o Section 10 Remote XID Test
- o Section 11 AUI Cable Fault Isolation Test
- o Section 12 MAU Test

# Diagnostics

# CAUTION

Never abort LANDAD when Sections 3, 4, 9, or 10 are specified. This can cause the diagnostic to lose functionality the next time the diagnostic is run.

- To access the HELP facility for LANDAD, enter HELP to the DUI prompt. The HELP messages are described in the Online Diagnostics Subsystem Manual, P/N 09740-90020.
  - LANDAD is not an interactive diagnostic, and contains no user accessible commands.
- Type EXIT to terminate the LANDAD diagnostic. Control will return to the Online Diagnostic System.

# I/O Test Tool (IOTT)

The I/O Test Tool (IOTT) is a utility intended for online diagnosis of I/O related problems from any system terminal. Numerous commands, instructions, and program statements are available as inputs through I/O Test Tool.

### Mini-Operating Instructions

Before attempting to run the utility, ensure that the user has diagnostic level 0 security as described in the Online Diagnostics Subsystem Utilities Manual, P/N 09740-90021.

1. Enter the following command to the MPE-XL prompt:

:SYSDIAG

2. Enter the following command to the DUI prompt:

DUI > RUN IOTT < RUN Command Options>

Refer to the Section on DUI for details concerning the RUN command options and the detailed IOTT command options in this section.

3. The diagnostic responds with a header and welcome message.

Once the I/O Test Tool is invoked, the following message will be displayed indicating an input request:

IOTT>

The four categories of input commands and the five categories of input Buffer Manipulation Instructions available for I/O Test Tool are provided in this section.

4. To exit IOTT type EXIT. Control will return to the Online Diagnostic System as shown by the appearance of the DUI prompt:

DUI>

For information on error messages that may appear when using IOTT, refer to Section 5 in the Online Diagnostics Subsystem Utilities Manual, P/N 09740-90021.

### **COMMAND SUMMARY**

The four categories of input commands available with IOTT are listed as follows:

### Control Commands (CC)

The following commands are used to control the current execution mode of I/O Test Tool:

ABORT EXIT RESUME

### Diagnostics

```
RUN[count]
SUSPEND
```

## User Program File Commands (UPFC)

The following commands are available to utilize user program files:

```
LOAD (filename)
PURGE (filename)
SAVE (filename)
SHOWFILE [file specifier string]
```

## Program Editing Commands (PEC)

The following commands can be used to manipulate the contents of the Program Storage Area:

```
DELETE [linenumber]
DELETE [linenumber]/[linenumber]
DELETE ALL
LIST [linenumber]
MODIFY [linenumber]
MOVE [linenumber]/[linenumber] TO [linenumber]
MOVE [linenumber] TO [linenumber]
RENUMBER [value]
```

#### Miscellaneous Commands (MC)

The following commands are available for general use:

```
\begin{array}{lll} \mbox{HELP [command, instruction, or statement name][:SYNTAX]} \\ \mbox{REDO} \end{array}
```

#### INSTRUCTION SUMMARY

The five categories of input Buffer Manipulation Instructions available for IOTT are as follows:

#### Test Environment Instructions (TEI)

The following instructions are used to set the environment for the use of I/O Test Tool:

```
ERRPAUSE ON
ERRPAUSE OFF
RELDEVICE LDEV=[ldev]
RELDEVICE PDEV=[pdev]
SETDEVICE LDEV=[logical device number]
SETDEVICE PDEV=[CA#][.DA#[.Device#[.Unit#]]]
SETTIMER {value}
SHOWDEV
```

#### **Buffer Manipulation Instructions (BMI)**

Buffer function instructions provide the availability to fill, modify, and display data which was used for the I/O request. The two types of buffers used are integer buffers (32-bit entities) and byte buffers (8-bit entities). For functions which involve two buffers, both buffers must be of the same type. The available instructions are:

```
ADJBUFF [buffer name]([index]),[value],[count]
ALTBUFF [buffer name]([index]),[value],[value]
ALTBUFF [buffer name]([index]),"ascii text"

COMPBUFF [buffer](index]),[buffer]([index]),[length],[count]

[similar]:[display mode]

COPYBUFF (buffer)((index)),(buffer)((index)),(length),[count]

DBUFF (buffer name) [index] [:display mode]

DBUFF (buffer name) [index] [:display mode]

DBUFF (buffer name),[length],(BYTE) [:STATUS]

DEFBUFF (buffer name),(length),(WORD) [:STATUS]

FILLBUFF [buffer]([index]),[value],[count]

FINCBUFF (buffer name)((index)),(start),(end)[,inc]

RELBUFF (buffer name)
```

#### Predefined I/O Request Instructions (PIORI)

The following instructions give all information needed for the predefined I/O request:

```
ABORTIO
EINCADDR (value)
EXECUTE {function}[,count][: UNBLOCK]
DSTATUS
INCADDR {value}
RESETIO
SETADDR CLY=(cylinder); HEAD={head}; SECT={sect}
SETADDR (value)
SETDATA {buffer}, {length}
SETOPTION {option}[,option]
SHOWPARM
```

#### HP-IB Device Adapter Program Instructions (HPIBPI)

I/O Test Tool provides instructions for creating unique HP-IB device adapter programs. This allows more control over the protocol between the HP-IB device adapter and a peripheral device. The instructions available are as follows:

```
{line number} CASEJUMP {value},{line number}[,line number]
CLEAR {value}
{line number} CRCCOMP {line number}
CRCINIT
CRCWRITE
{line number} DSJ {sindex},{line number},[line number],[line number]
```

#### Diagnostics

```
ENDHPIB
HALT (status length), (hstat)
IDENTIFY (sindex)
{line number} JUMP {line number}
ONTIMEOUT [timeout],[sindex],[line number]
PINDEX {value}
RBURST {secondary}, {buffer name}, {length}, {#burst}, {burstlen}
RDATA (secondary), (sindex), (length)
RDMA (secondary), (buffer name), (length)
SETHPIB
SHOWHPIB [:display mode]
TIMEOUTOFF
TIMESTAMP (sindex)
UNLOCK
WAITPOLL [:nobreak]
WBURST {secondary},{buffer name},{length},{#burst}[:eoi]
WDATA (secondary), (buffer name), (length)[:eoi]
WDMA (secondary), (buffer name), (length) [:eoi]
WINTERF (buffer name), (length)
```

For further information on HP-IB Device Adapter Programs, refer to the HP 27110B CIO/HP-IB Interface Card Technical Reference and Programming Manual, P/N 27110-90005.

#### HP-CIO DMA Chain Instructions (HPCIOI)

I/O Test Tool provides the following instuctions to control the protocol across the HP-CIO:

```
ADDQUAD {order ID}, {buffer name}, {length}[:hpcio optional] ADDQUAD {cmd value}, {buffer name}, {length} ENDHPCIO SETHPCIO SHOWHPCIO [:display mode]
```

## PROGRAM STATEMENT SUMMARY

The following are program command statements available in IOTT:

```
COMMENT
DO-LOOPTO
GOTO
IF-THEN/IFN-THEN
PAUSE
PRINT
STOP
```

# **HP-CIO Channel Adapter Utility (CADIAG)**

The HP-CIO Channel Adapter Utility (CADIAG) is a utility program providing capability to test online the functionality of the CIO Channel Adapter, which is itself a Field Replaceable Unit (FRU).

### Mini-Operating Instructions

1. Enter the following command to the MPE-XL prompt:

:SYSDIAG

Enter the following command to the DUI prompt:

DUI > RUN CADIAG < RUN Command Options>

Refer to the DUI section in the Online Diagnostics Subsystem Manual, P/N 09740-90020 for details concerning the RUN command options.

3. The diagnostic responds with a header and welcome message.

If the sections and steps to be run aren't specified, the following default sections and steps will be executed:

#### DEFAULT SECTIONS

- o Section 3 Identify
- o Section 6 Status
- o Section 8 Description

### ADDITIONAL SECTIONS AVAILABLE

- o Section 9 Rollcall
- o Section 10 Subchannel Hardware Status

Enter HELP to provide a summary of the DUI commands to be printed.

4. Type EXIT to exit CADIAG and control will return to the Online Diagnostic System.

Refer to Section 3 in the Online Diagnostics Subsystem Utilities Manual, P/N 09740-90021, for a list of error messages which may appear when using CADIAG.

# System and Memory Log Analysis Tool (LOGTOOL)

The system and memory log analysis tool (LOGTOOL) provides capability to perform various operations on the system log files. Error logs may be identified, deleted, and created. Timing intervals for background log analysis may be displayed and reset.

## Mini-Operating Instructions

1. Enter the following command to the MPE-XL prompt:

:SYSDIAG

2. Enter the following command to the DUI prompt:

```
DUI > run logtool
```

3. The utility responds with a header and welcome message.

Refer to the detailed LOGTOOL command explanations in the Online Diagnostics Subsystem Utilities Manual, P/N 09740-90021, for more details. Once LOGTOOL has been invoked the following prompt will be displayed indicating an input request:

LOGTOOL>

Respond by entering a logtool command along with any necessary data, parameter(s), or options.
 Entering HELP will access the logtool HELP facility and display a complete list of logtool commands.

The four categories of input commands available are:

- · System Log File Commands (SFL).
- Diagnostic Log File Commands (DLF).
- Memory Log File Commands (MLF).
- Miscellaneous Commands (MC).

The following commands listed with their command category are available in LOGTOOL:

```
DIAGRPT (DLF)
                                PURGEDIAG (DLF)
DISPLAYLOG (MC)
                                PURGESYSLOG (SLF)
EXIT (DLF)
                                PURGEWORK (SLF)
HELP (MC)
                                REDO (MC)
LAYOUT (SLF)
                                SELECT (SLF)
                                STATUS (SLF)
LIST (SLF)
MEMCLR (MLF)
                                SUSPEND (MC)
MEMRPT (MLF)
                                SWITCHLOG (SLF)
MEMTIMER (MLF)
                                TYPES (SLF)
```

5. Type EXIT to leave the HELP facility or to terminate any current logtool process.

For a list of warning and error messages that may appear when using LOGTOOL, refer to the Online Diagnostics Subsystem Utilities Manual, P/N 09740-90021.

# System Map (SYSMAP)

The System Map (SYSMAP) utility provides information concerning these three areas of the HP Precision Architecture Computer System: Input/Output System (IOMAP), Central Processing Unit(s) (CPUMAP), and System Memory (MEMMAP). Maps of these three areas are available only on the host system.

#### Mini-Operating Instructions

1. Enter the following command to the MPE-XL prompt:

:SYSDIAG

2. Enter the following command to the DUI prompt:

```
DUI > run sysmap
```

3. The utility responds with a header and welcome message.

Refer to the command descriptions in the Online Diagnostics Subsystem Utilities Manual, P/N 09740-90021, for details of SYSMAP commands. SYSMAP has no RUN command options. Once SYSMAP has been invoked the following prompt is displayed indicating an input request:

ENTER MAP>

3. Typing HELP will cause SYSMAP to list a menu of the following global SYSMAP commands:

```
IOMAP
CPUMAP
MEMMAP
CONFIRM (ON/OFF)
TIMEOUT
SUSPEND
EXIT
```

Respond with one of the above six commands.

4. Type EXIT to terminate any current mapping process or to leave the HELP facility.

# **HP-UX Logging Facility**

The HP-UX Logging Facility provides a means of obtaining and decoding Diagnostic Event Messages (DEMs). The acquisition of the event messages is handled by the HP-UX DELOG (Diagnostic Event Logger) program. To decode these messages, use the HP-UX DECODE (Diagnostic Event Decoder) program.

## Mini-Operating Instructions

Enter the following command to the system prompt:

:SYSDIAG

The system responds with a header and welcome message. Enter HELP for assistance.

DUI (n)>

2. Enter desired command by preceeding each command entry with an exclamation point:

```
DUI (n)> ! delog or DUI (n)> ! decode
```

Use the DELOG command when the altering operation of the Delog background log process deamon is desired. Use the DECODE command when decoding and displaying a particular Diagnostic Event Message (DEM).

- Refer to the Online Diagnostics Subsystem Utilities Manual (P/N 09740-90021) for detailed operating instructions or explanations of DELOG and DECODE.
- 4. Type EXIT to terminate program or to leave the HELP facility.

# MPE-XL Online Diagnostic Installer

The MPE-XL Online Diagnostic Installer utility permits online updating of the Online Diagnostic Subsystem and its directory. This utility will serve as a remote and onsite support tool.

### Mini-Operating Instructions

1. Enter the following command to the MPE-XL prompt:

```
:run diaginst
```

After the introductory message is displayed at initialization, the following main menu will be displayed:

#### Available Commands:

```
ADD
CORRECT
EXIT
LIST
REMOVE
SHOWMSG
SYSTEM
XCHECK
INSTALLATION TASK (select by number) >
```

- Enter HELP to any prompt for assistance on the use of this program. Another facility available is HELP "GENERAL/COMMANDS/HELP/RECOVER".
- To leave this program, enter EXIT as displayed in the main menu of MPE-XL Online Diagnostic Installer.

For a list of warning or error messages that may appear when using the program, refer to the Online Diagnostics Subsystem Manual, P/N 09740-90020.

## Diagnostics

# MPE-XL Online Diagnostic Implementation

The MPE-XL operating system has components and conditions specific for implementation of the Online Diagnostic Subsystem.

## Implementation Dependent Information

Maximum USE file nesting level: 10

Maximum processes per DUI: 10

User Interrupt Key: Control Y

Command (REDO) Stack depth: 5

Input/Output Files: 80 Character Records

Unnumbered

Directory "path": file. group. acct

Monitor Version: xx.yy

# MPE-XL Specific Diagnostic Procedures/Features

\*\*\* To be supplied at a later date. \*\*\*

# **HP-UX** Online Diagnostic Implementation

The HP-UX operating system has components and conditions specific for implementation of the Online Diagnostic Subsystem.

## Implementation Dependent Information

Maximum USE file nesting level: 10

Maximum processes per DUI: System Dependent

User Interrupt Key: Control C

Command (REDO) Stack depth: 10

Input/Output Files: Character String (80 max)

Directory "path": /dir/dir/.../file

Monitor Version: n/a

# HP-UX Specific Diagnostic Procedures/Features

\*\*\* To be supplied at a later date. \*\*\*

# **ADJUSTMENTS**

SECTION

This section contains procedures for power supply adjustments for the HP 3000 Series 900 Model 930 and HP 9000 Series 800 Model 840 Computer Systems.

Power	Supply	Removal/R	eplacement -	- 1	Power Supply #1	6-	٠
Power	Supply	Removal/R	eplacement -	- :	Power Supplies #2 and #3	6-	٠,

#### Adjustments

# Power Supply Removal/Replacement - Power Supply #1

The following procedure describes how to remove power supply #1 from the left side of the card cage:

- Turn off Main Power Breaker (located on the rear of cabinet).
- 2. Open front door and disconnect AC power cord from front of Power Supply #1. See Figure 6-1.
- 3. Remove the flat control panel cable from system monitor.
- Remove four screws holding system monitor in place and slide the system monitor out one inch in
  its slides without disconnecting the attached cables.
- 5. Remove the four screws and lock washers holding power supply in place.
- 6. Grasp and pull power supply to slide out of cabinet on its guides.
- 7. Install new power supply module by reversing this procedure.

## CAUTION

To prevent damage to the computer system and/or power supply, ensure power supply is fully seated in cabinet, without forcing it.

- Reconnect AC power cord to Power Supply #1.
- 9. Turn on Main Power Breaker and check PS1 voltage test points (located on system monitor) for proper voltages. Refer to Table 4-6 (Troubleshooting, Section 4) for the power supply test points and their voltage specifications. If voltages are out of tolerance, replace the power supply again. No adjustments are required.
- 10. Verify that system performs a normal boot-up.

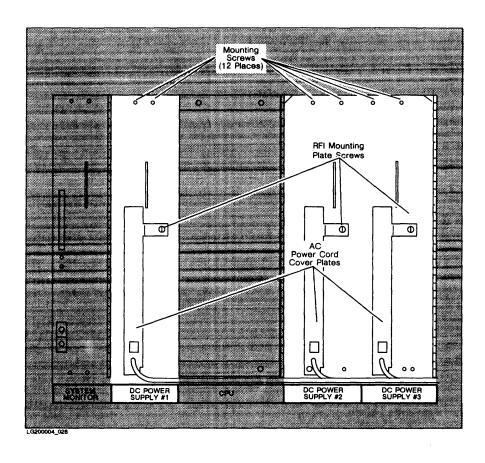


Figure 6-1. Location of Power Supplies

# Power Supply Removal/Replacement - Power Supplies #2 and #3

The following procedure describes how to remove power supply #2 or #3 from the right side of the card cage:

- 1. Turn off Main Power Breaker (located on rear of cabinet).
- Open front door and disconnect AC power cords from each power supply (#1, #2, and #3). See Figure 6-1.
- Remove the eight mounting screws and lockwashers holding the RFI plate and power supplies in place.
- Loosen the two captive, extruded, RFI plate mounting screws and use them to pull the RFI plate away from the power supplies.
- Grasp and pull the applicable power supply handle to slide the power supply out of cabinet on its guides.
- Install new power supply module by reversing this procedure, ensuring that the mounting screws are aligned before tightening.

## CAUTION

To prevent damage to the system and/or power supplies, ensure each power supply is fully seated in cabinet, without forcing it.

- 7. Reconnect AC power cords to all of the power supplies.
- 8. Turn on Main Power Breaker and check PS2 or PS3 voltage test points (located on system monitor) for proper voltages. Refer to Table 4-6 (Troubleshooting, Section 4) for the power supply test points and their voltage specifications. If voltages are out of tolerance, replace applicable power supply again. No adjustments are required.
- 9. Verify that system performs a normal boot-up.

# **PERIPHERALS**



This section describes the devices supported on the HP 3000 Series 900 Model 930 and HP 9000 Series 800 Model 840 Computer Systems.

# Peripherals

Table 7-1. MPE-XL Default Device Configuration

LDEV#	I/O-PATH	CLASS NAME
1	8. 0. 0	DISC; SPOOL
4	8.1.0	CONSOLE
12	8. 2. 6	EPOC; BONSAI; PP; LP; FASTLP
13	8. 2. 7	LP; CIPER; SLOWLP
14	8. 2. 3	TAPE; BUCKHORN
15	8. 2. 4	JOBTAPE
20	8. 0. 1	DISC
21	8. 0. 2	DISC
22	8. 0. 3	DISC
23	8. 2. 2	

Table 7-2. HP-UX Default Device Configuration

LV#	I/O-PATH	CLASS NAME	
0	8. 0. 0	DISC	
1 1	8. 0. 1	DISC	
2	8. 0. 2	DISC	
3	8. 0. 3	DISC	
0	8.1.0	MUX (6 PORT)	
1	8. 2. 0	PRINTER	
0	8. 2. 1	PRINTER	
1	8. 2. 2	TAPE	
0	8. 2. 3	TAPE	
2	8. 2. 4	TAPE	
i 0	8. 2. 7	INSTRUMENT	
1	8. 3. 0	MUX	
0	8.4.0	LAN	
0	8. 5. 0	GPIO	
4	8.6.0	DISC	
5	8. 6. 1	DISC	
6	8.6.2	DISC	
7	8.6.3	DISC	
2	8. 7. 1	PRINTER	
3	8. 7. 2	TAPE	
4	8. 7. 3	TAPE	
1	8. 7. 7	INSTRUMENT	
2	8. 8. 0	MUX	
3	8. 9. 0	MUX	
4	8.10.0	MUX	
5	8.11.0	MUX	
1	8.12.0	ACCESS PORT	

# **REPLACEABLE PARTS**

SECTION

8

The Replaceable Parts Catalog provides illustrations and parts lists to assist the user in locating replaceab	i
assemblies for the HP 3000 Series 900 Model 930 and HP 9000 Series 800 Model 840 Computer System	15
The catalog contains part number data for the Customer Engineer (CE) when parts replacement necessary.	i

# Replaceable Parts

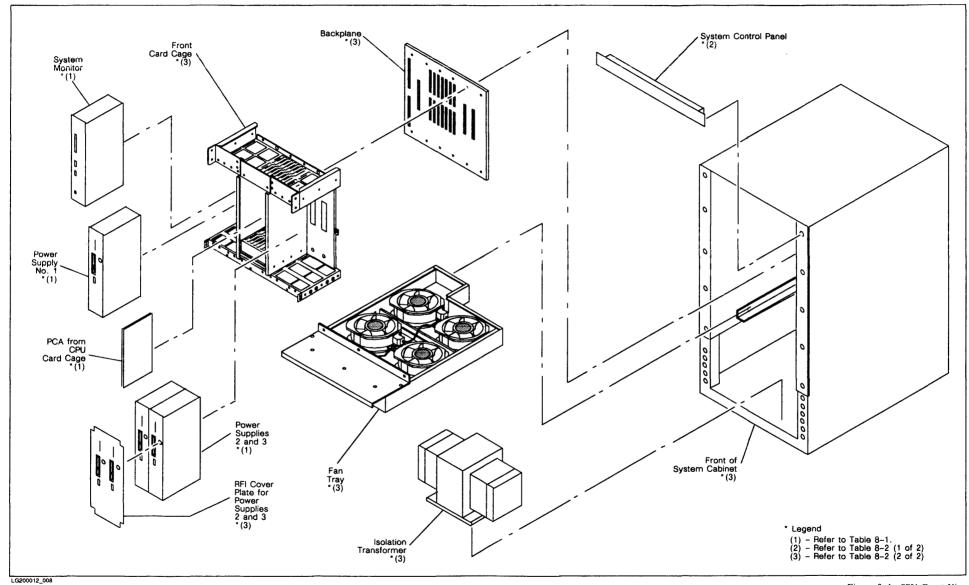


Figure 8-1. SPU, Front View

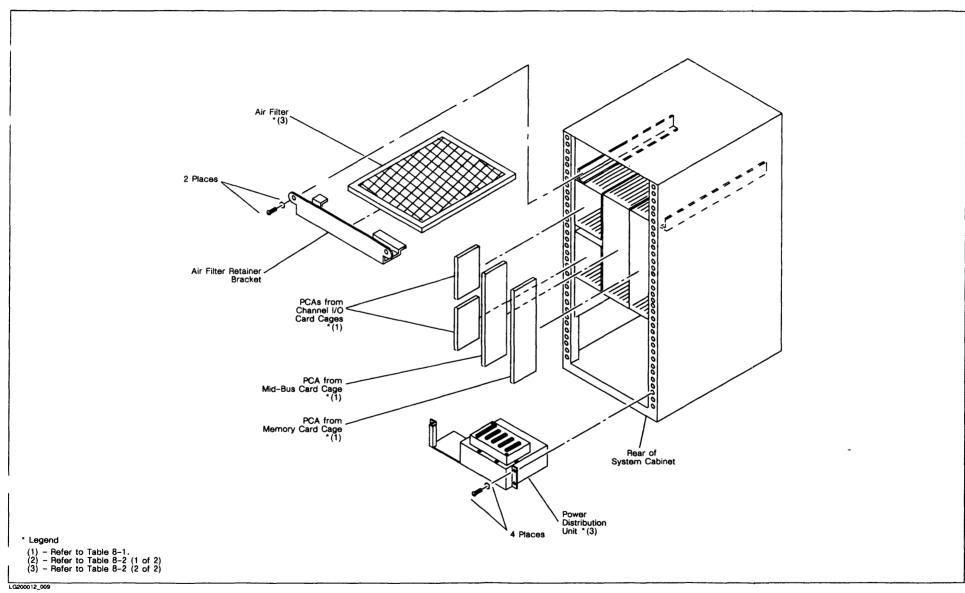


Figure 8-2. SPU, Rear View

# REPLACEABLE PARTS CATALOG

The replaceable parts catalog is organized in the order of Exchange Parts and Non-Exchange Parts. Each system diagram (exploded view) shown in Figures 8-1 and 8-2, contains a legend that represents parts listed in Tables 8-1 and 8-2.

Table 8-1. Exchange Parts

HP PART NO.	HP PART NO. (EXCHANGE)	DESCRIPTION
09740-60101	09740-69511	PCA-RGSTR File (CPU Register File Unit)
09740-61701	09740-69671	PCA-E Unit (CPU Execution Unit)
09740-60301	09740-69531	PCA-I Unit (CPU Instruction Unit)
09740-61501	09740-69651	PCA-4X TLB (CPU Translation Lookaside Buffer)
09740-61601	09740-69661	PCA-4X CACHE (CPU Cache)
09740-60603	09740-69563	PCA-CIOA MB (Channel I/O, C1)
09740-60705	09740-69575	PCA-CIOA CIO (Channel I/O, C2)
09740-60904	09740-69594	PCA-SYS MONITOR (System Monitor)
09740-61001	09740-69601	PCA-3MB Memory Controller
19741-60001	19741-69001	PCA-5MB Memory Array
19742-60001	19742-69001	PCA-Floating Pt (CPU Floating Point Coprocessor)
19745-60001	n/a	Analyzer Card
5061-2537	5061-2541	PCA-AP (CIO Access Port)
0950-1788	0950-1806	Assy - Power Supply, 300 Watt

# NOTE

All exchange assemblies include ROMs. The ROMs will only be changed as part of update procedures.

Table 8-2. Non-Exchange Parts (1 of 2)

HP PART NO.	DESCRIPTION
09740-60010	Cable, PDU - Transformer
09740-60015	CA-CNTRL PANEL (INT/EXT Display)
09740-60017	CA-SYS MON, CNTRL (System Monitor, Control)
09740-60018	CA-SYS MON, BATT (System Monitor Battery Cable)
09740-60019	CA-SYS MON, PDU (System Monitor, PDU)
09740-60024	CA-CHAN ADAPT A, Channel Adapter A Cable
09740-60025	CA-CHAN ADAPT B, Channel Adapter B Cable
09740-60803	PCA-CIO Buffer (Channel I/O, C3)
09740-61101	PCA-Display Board, External
09740-61202	PCA-Display Board, Internal
19746-60010	Cable, CIO Buffer
8120-4859	AP CBL ASYM. LEGS (Access Port Cable)

Table 8-2. Non-Exchange Parts (2 of 2)

HP PART NO.	DESCRIPTION
1390-0345	Key, SPU Cabinet
1390-0741	Lock, door
1420-0341	Battery - Lithium
2110-0051	Fuse 10A SB, Power Supply
3105-0208	CKT BKR-5 AMP (Fan Circuit Breaker)
3105-0209	CKT BKR-15 AMP (Battery Circuit Breaker)
3150-0504	Filter, Air
3160-0478	Fan, AC
9100-4177	XFMR-ISLN (Isolation Transformer)
09740-00027	Door, Front CPU
09740-00029	Door, I/O Mid-Bus
09740-00030	Door, CIO Upper
09740-00031	Door, Memory Mid-Bus
09740-00042	Panel Cover, PDU
09740-00049	Cover, Power Supply
09740-00051	Door, CIO Lower
09740-40002	Panel, Control
09740-60043	Backplane
09740-60003	Assy - Card Cage
09740-60005	Assy - Fan Tray
09740-60007	BATT 10V, 10AH (Battery Assembly)
09740-60008	Assy - PDU (Power Distribution Unit)
09740-60012	Assy - Door, Front
09740-60041	Assy - Door, Rear
09740-61401	TTL SPU CAB (SPU Cabinet Bay Assembly)
19743-60001	Parallel Card
19770-67901	Service Kit
19771-67801	Cable Kit

## NOTE

If the transformer fails, it is recommended that the SPU Cabinet Bay Assembly (P/N 09740-61401) be replaced.

<sup>\*\*\*</sup> The assemblies with their corresponding callouts in Figures 8-1 and 8-2 were not able to be a completely represented at this time. \*\*\*

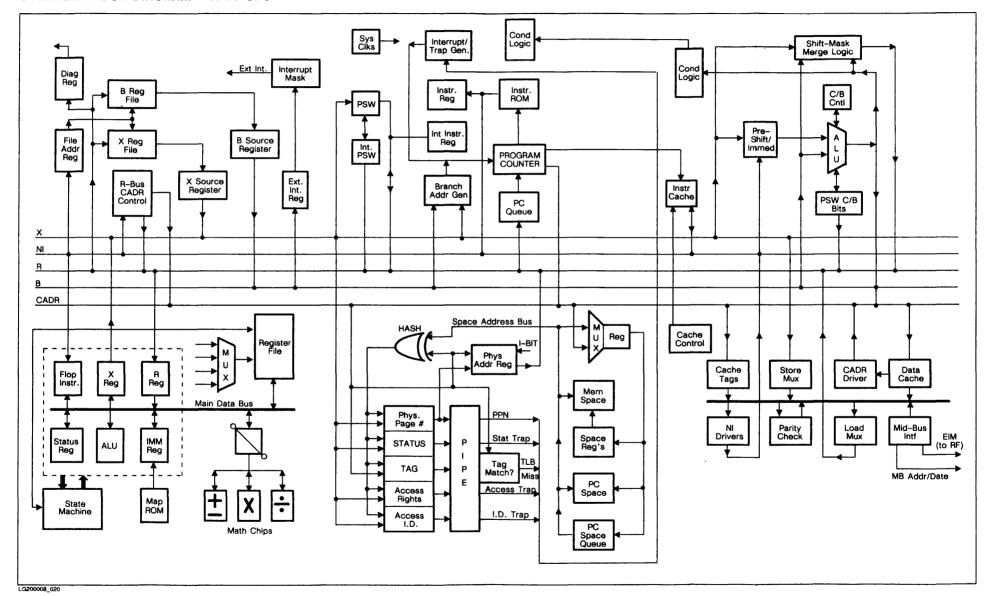
# **DIAGRAMS**

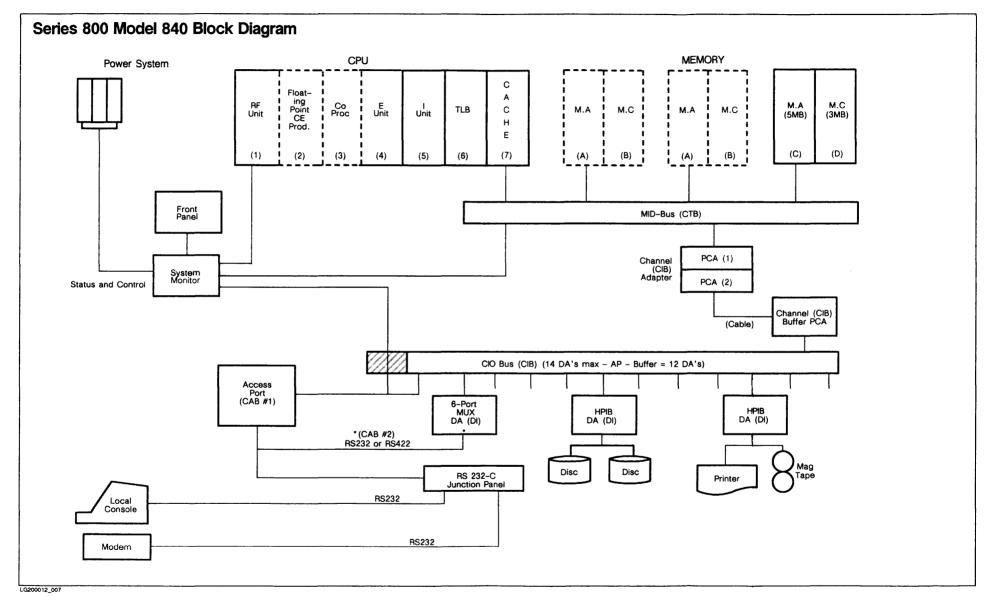


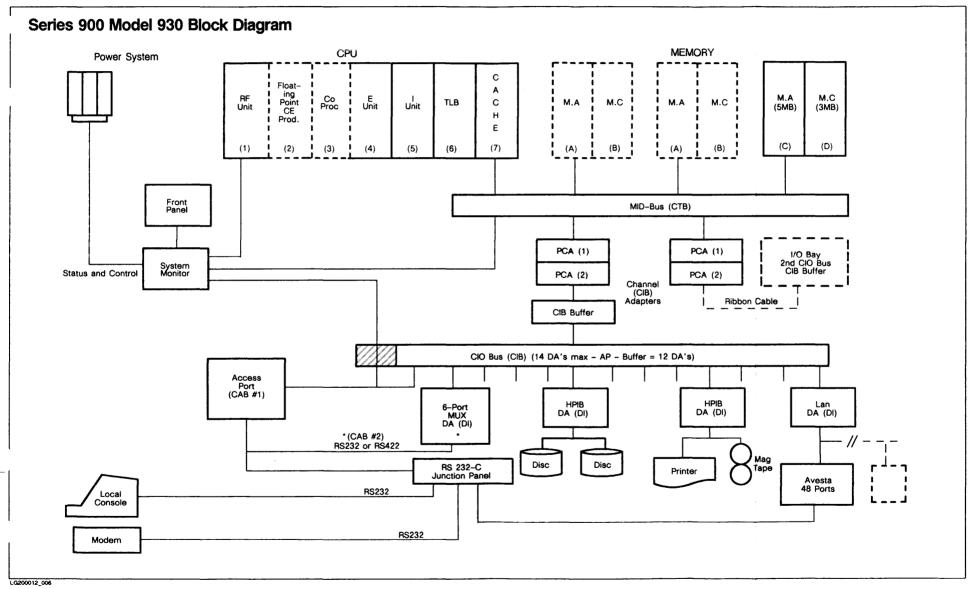
The diagrams provided in this section are to aid the CE in troubleshooting the system.

Overall Block Diagram - 9740 CPU
Series 800 Model 840 Block Diagram
Series 900 Model 930 Block Diagram
Power Distribution Chart
Power Distribution System
Expansion Bay/Module Block Diagram9-12
Expansion Bay Power Distribution Chart
Expansion Bay Power Distribution System
Cache Unit (CA+) Block Diagram
Execution Unit (EU+) Block Diagram
Floating Point Unit (FP) Block Diagram 9-17
Instruction Unit (IU) Block Diagram 9-18
Register File Unit (RF) Block Diagram
Translation Lookaside Buffer (TL+) Block Diagram
System Monitor Module
Front Cabinet PCAs
HP 9000 Series 800 Model 840 Front/Rear Cabinet PCAs
HP 3000 Series 900 Model 930 Front/Rear Cabinet PCAs
System Monitor Card Backplane Connectors
Row C Connector Definition for Processor Board (CIO slot 12)
System Monitor Card Front Panel Connectors

# **OVERALL BLOCK DIAGRAM - 9740 CPU**







### POWER DISTRIBUTION CHART

#### **POWER SUPPLY #1**

- Mid-bus slots 3-13 +5V
- +12V Mid-bus slots 3-13, C2, SM
- -12V Mid-bus slots 3-13, C1, C2, SM
- +28V Not Used
- 25KHz Not Used
- PFW- Power Fail Warning Status Signal
- PON+ Power On Status Signal

#### **POWER SUPPLY #2**

- +5V RF, EU+, C1, IU, TLB, CA+
- +12V Not Used
- -12V Not Used
- +28V SM
- 25KHz Not used
- PFW- Power Fail Warning Status Signal
- PON+ Power On Status Signal

#### **POWER SUPPLY #3**

- +5V Mid-bus slots 1-2, CIO slots 0-13
- +12V Mid-bus slots 1-2, CIO slots 0-13
- -12V Mid-bus slots 1-2, CIO slots 0-13
- +28V SM
- 25KHz Not Used
- PFW- Power Fail Warning Status Signal
- PON+ Power On Status Signal

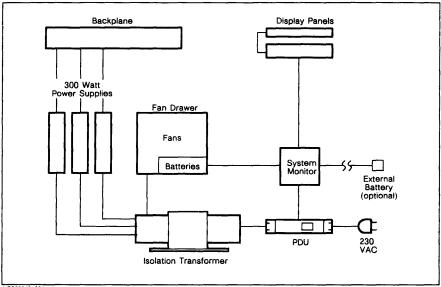
A separate +5S (+5 secondary) voltage is provided from a regulator on the System Monitor Module used to sustain memory.

A power distribution matrix for card slots of the HP 3000/930 and HP 9000/840 Computer Systems is illustrated in Figure 9-1.

	POWER SUPPLY 1	POWER SUPPLY 2	POWER SUPPLY 3	SYSTEM MONITOR CARD	INTERNAL BATTERY	EXTERNAL BATTERY
+5 VOLTS	MID-BUS SLOTS 3-13	RF, C1, EU, IU, TLB, CA	MID-BUS 1 and 2 CIO 0-13			
+5S * VOLTS				CIO 12, CA, IU, MID-BUS 8-13		
+10 VOLTS					SYSTEM MONITOR CARD	
+12 VOLTS	MID-BUS 3-13, C2, SYSTEM MONITOR		MID-BUS 1 and 2 CIO 0-13			SYSTEM MONITOR CARD
-12 VOLTS	MID-BUS 3-13, C1 (FPP), C2, SYSTEM MONITOR		MID-BUS 1 and 2 CIO 0-13			
+28 VOLTS		SYSTEM MONITOR CARD	SYSTEM MONITOR CARD			
* 5	5 VOLTS, SECO	ONDARY IS G	ENERATED BY	THE SYSTEM	MONITOR CA	RD.

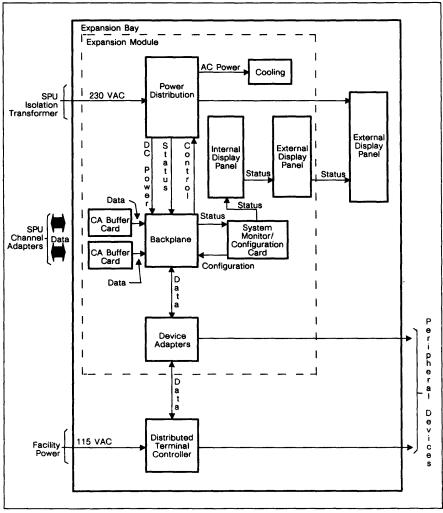
Figure 9-1. Power Distribution Matrix for Card Slots

# **POWER DISTRIBUTION SYSTEM**



LG200012\_001

# **EXPANSION BAY/MODULE BLOCK DIAGRAM**



LG200012\_002

## **EXPANSION BAY POWER DISTRIBUTION CHART**

## POWER SUPPLY (300 W)

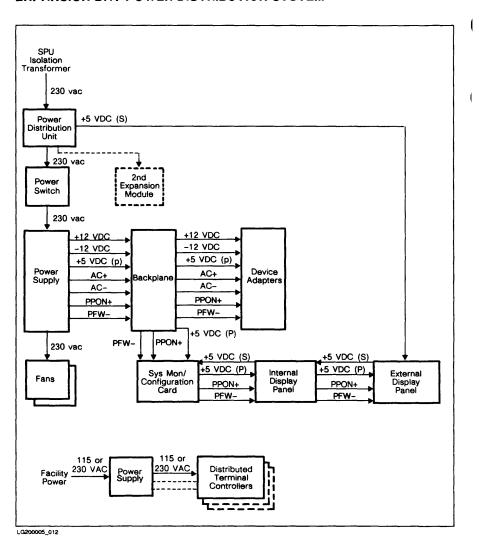
+5V(DC) To Backplane, SM/Configuration Card, Int. /Ext. Display Panels, Device Adapters

+12V(DC) To Backplane, Device Adapters
-12V(DC) To Backplane, Device Adapters
AC+ To Backplane, Device Adapters
AC- To Backplane, Device Adapters

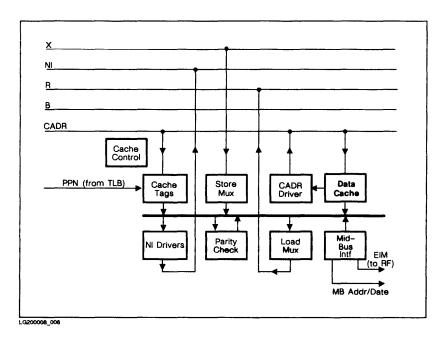
PPON+ Primary Power On Status Signal PFW- Power Fail Warning Status Signal

Facility Power to three Distributed Terminal Controllers (DTCs)

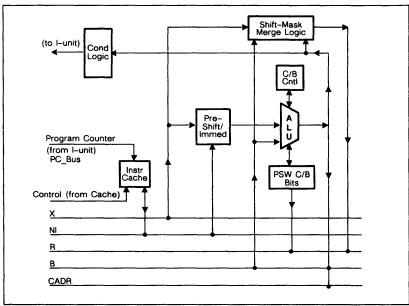
### **EXPANSION BAY POWER DISTRIBUTION SYSTEM**



# **CACHE UNIT (CA+) BLOCK DIAGRAM**

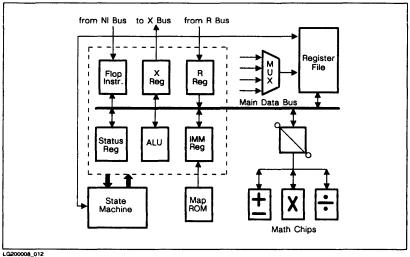


# **EXECUTION UNIT (EU+) BLOCK DIAGRAM**

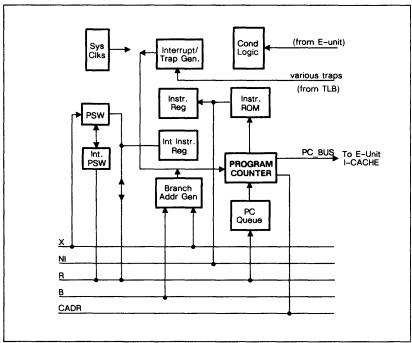


LG200008\_013

# FLOATING POINT UNIT (FP) BLOCK DIAGRAM

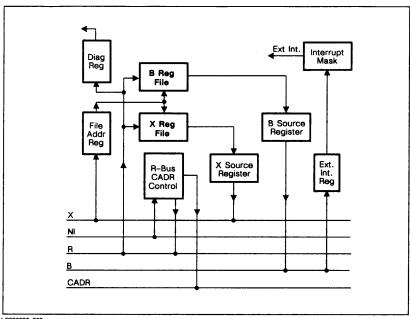


# INSTRUCTION UNIT (IU) BLOCK DIAGRAM



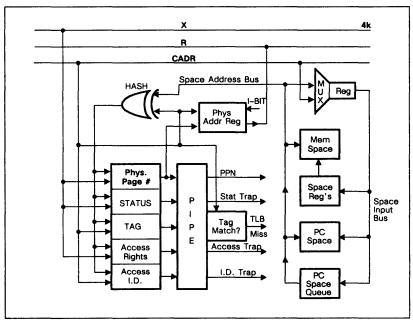
LG200008\_002

# REGISTER FILE UNIT (RF) BLOCK DIAGRAM



LG200008\_003

# TRANSLATION LOOKASIDE BUFFER (TL+) BLOCK DIAGRAM



# SYSTEM MONITOR MODULE

	DIAGNOSTIC SWITCH
	CONTROL PANEL CONNECTOR
	PON1 PON2 PON3 MB.PON MB.PFW +3V1 +3V2 -12VPS1 +12VPS3 +12VPS3 +12VPS3 +10BATTERY -5VPS1 +5VPS2 +5VPS3 +5VS2 +28VPS3 +28VPS3 +28VPS3 +28VPS3
0	SHDN
	BATTERY CONNECTOR
	PDU CONNECTOR  EXTERNAL BATTERY CONNECTOR

# FRONT CABINET PCAS

SYSTEM MONITOR	
POWER SUPPLY #1	
Register File Unit (RF)	
Floating Point Unit (FP)	
Analyzer (Optional)	
Execution Unit (EU+)	
Instruction Unit (IU)	
Translation Lookaside Buffer (TL+)	
Cache (CA+)	
POWER SUPPLY #2	
POWER SUPPLY #3	

# HP 9000 SERIES 800 MODEL 840 FRONT/REAR CABINET PCAS

									HP.	-UX									
	SL	ots	_0		_ 1	2	3	4	5	6	7				_				
		FRONT CAB-NET	SYSTEE SOZ-TOR	POWER SUPPLY #1	RF	FLOATING POIZE		EU+	U	T L +	CA+	POWER SUPPLY #2	; ; ;	POWER SUPPLY #3		CPU & POWER			
								CON	FIGU	RATIO	ON O	NLY							
SLOTS REARR CAABINET	O ID-B D-00	1 18F UMUX	2 ፲፻-፡፡ ፫ጳር ተፈቦ። ፲፻	XCKC OZN 8	4 142	5 GP10	6 IP-B D-0C	1 CTANNUL	2 CHARREL		4 PARALLEL		8 3RD A	9 380 0021	10 2ND A	11 22D CONT	1 ST MEMORY	13 MEMORY CO	1/O & ME
	7 -200-0025m2-	8 3EO DEDX	9 4HI DEDX	10 5FH UMUX	11 6TH UMUX	12 ACCESS PORT	13 C-O BUFFER (C3)		M-□ BUS (C)		I JUL		ARRAY	CONTROLLER	ARRAY	CONTROLLER	HY ARRAY	CONTROLLER	MEMORY
		CIO	) (C	IB) C	ARD	s			N	IID_B	US (	(CTB)			MEI	MOR	1		•

## SYSTEM MONITOR CARD FRONT PANEL CONNECTORS

The four connectors on the front edge of the System Monitor Card are described as follows:

- Il is a 50 pin connector to the front control panel.
- J2 is a 9 pin connector to the internal backup battery on the fan tray.
- J3 is a 5 pin connector to the AC Circuit Breaker (OVERTEMP SHUTDOWN and BATTERY ENABLE) on the PDU.
- J4 is a 2 pin connector provided for an optional external battery.

See Figure 9-2 for location of the front panel connectors.

#### J1 PIN ALLOCATION

ROW	<b>A</b>	ROW	В
1	+5V	1	+5V
2	DIAG.OUT 8+	2	DIAG.OUT 9+
3	DIAG.OUT 10+	3	DIAG.OUT 11+
4	DIAG.OUT 12+	4	DIAG.OUT 13+
5	DIAG.OUT 14+	5	DIAG.OUT 15+
6	GND	6	GND
7	DIAG.OUT 16+	7	DIAG.OUT 17+
8	DIAG. OUT 18+	8	DIAG.OUT 19+
9	DIAG. OUT 20+	9	DIAG.OUT 21+
10	DIAG. OUT 22+	10	DIAG.OUT 23+
11	GND	11	GND
12	DISPLAY LATCH (DIAG. OUT 1+)	12	DISPLAY BLANK (DIAG.OUT 7+)
13	+12V	13	+12V
14	OVERTEMP SHUTDOWN -	14	MB. PON+
15	BATTERY CHARGING -	15	MB. PFW-
16	AP. PRESET +	16	+5VB
17	BATTERY IN USE -	17	SELFTEST.OK +
18	TEMP. OK +	18	GND
19	OVERTEMP WARNING +	19	FP. REMOTE -
20	GND	20	GND
21	SELFTEST.FAIL +	21	FP. RESET -
22	I/O ERROR +	22	-12V
23	SYS.FAIL -	23	REMOTE. ENABLE -
24	CHK. SYS. +	24	SYS. FCTN -
25	+5VS1	25	+5VS2

#### **J2 PIN ALLOCATION**

7 +10V BATTERY 8 +10V BATTERY 9 +10V BATTERY

#### J3 PIN ALLOCATION

#### **J4 PIN ALLOCATION**

1 GND	1 OVERTEMP SHUTDOWN +	1 +12V BATTERY (EXT.)
2 GND	2 +5VS1	2 GND
3 GND	3 GND	
4 GND	4 BATTERY ENABLE -	
5 N.C.	5 +10V BATTERY	
6 +10V BATTERY		

## NOTE

Use +5S1 secondary power for Mid-bus Slots 11, 12, and 13. Use +5S2 secondary power for Mid-bus Slots 8, 9, 10, and the IU and CA boards.

# Row C Connector Definition for Processor Board (CIO slot 12)

Row C	
1 FGND	16 GND
2 CTL.ENABLE -	17-20 RESERVED
3 RESET.SYS -	21 GND
4 GND	22 RESERVED
5 SELFTEST.SYS -	23 GND
6 FP.DATA +	24-26 RESERVED
7 GND	27 GND
8 FP.CLK +	28-33 RESERVED
9 REMOTE.EN-	34 GND
10 GND	35-38 N.C.
11 TXD-OUT-DP	39 +5S
12 RXD-IN-DP	40 +5V
13 GND	
14-15 RESERVED	

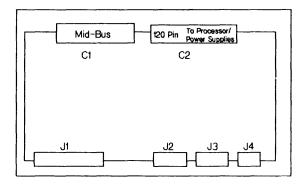


Figure 9-2. System Monitor Board Connector Location.

## SYSTEM MONITOR CARD BACKPLANE CONNECTORS

The System Monitor Card has the two (2) following backplane connectors:

- C1 (P1) is the standard Mid-bus connector.
- C2 (P2) is a 120 pin connector to the processor and power supplies.

See Figure 9-2 for location of the backplane connectors.

### **C2 PIN ALLOCATION**

ROW	A	ROW	R	ROW	C
1	A +28V (P/S #2) THERMO #3 THERMO #1 N.C.	1			+28V (P/S #2)
ż	THERMO #3	2	GND C2.RESET.SWITCH - -12V (P/S #3) GND	2	THERMO #4
3	THERMO #1	3	-12V (P/S #3)	3	THERMO #2
4	N.C.	4	GND	4	N.C.
5	SELFTEST. SYS -	5	FP.DATA+	5	REM. ENABLE -
6	CTL ENABLE -	6	FP.CLK +	6	RESET. SYS -
7	SELFTEST.SYS - CTL ENABLE - GND	7	FP. DATA+ FP. CLK + +5V (P/S #3)	7	GND
8	SEC. PWR. SHDN +	8	CIOEXT2.PFW-	8	+12V (P/S #3)
9	C2. DIAG. IN 11+	9	SEC.PWR.START+	9	CIOEXT1. PFW-
10	CND	10	GND	10	GND
11	C2.DIAG.IN 8+	11	GND C2.DIAG.IN 9+	11	C2.DIAG.IN 10+
12	C2. DIAG.IN 5+	12	C2.DIAG.IN 6+	12	C2. DIAG. IN 7+
13	UND	13	UND	13	GND
14		14	C2.DIAG.IN 3+ C2.DIAG.IN 0+	14	C2.DIAG.IN 4+
15	C2. DIAG. IN 2+ C2. DIAG. OUT 23+	15	C2.DIAG.IN 0+	15	C2.DIAG.IN 1+
16	+5S2	16	+5\$2	16	+582
17	C2.DIAG.OUT 20+	17	C2.DIAG.OUT 21+	17	C2.DIAG.OUT 22+
18	C2.DIAG.OUT 17+	18	C2. DIAG. OUT 18+	18	C2.DIAG.OUT 19+
	GND	19	GND	19	GND
20	C2.DIAG.OUT 14+	20	C2. DIAG. OUT 15+	20	C2.DIAG.OUT 16+
21	C2.DIAG.OUT 11+	21	C2.DIAG.OUT 12+	21	C2. DIAG. OUT 13+
	+5S2		+5S2		+5S2
23	C2. DIAG. OUT 8+	23	C2.DIAG.OUT 9+	23	C2. DIAG. OUT 10+
24	C2.DIAG.OUT 5+	24	C2. DIAG. OUT 6+	24	C2. DIAG. OUT 7+
25	GND	25	+5\$2		GND
	C2. DIAG. OUT 2+				
27	CONFLICT 6-		C2. DIAG. OUT 0+		C2. DIAG. OUT 1+
28	GND CONFLICT 3-	28	GND CONFLICT 4-		GND
29	CONFLICT 3-	29	CONFLICT 4-		CONFLICT 5-
	ARBITRATE-(SLOT#13)	30	CONFLICT 1-		
	GND	31	+5V (P/S #2)	31	GND
32	ARBITRATE-(SLOT#10) ARBITRATE-(SLOT#7)	32	ARBITRATE-(SLOT#11) ARBITRATE-(SLOT#8)	32	ARBITRATE-(SLOT#12)
33	ARBITRATE-(SLOT#7)	33	ARBITRATE-(SLOT#8)	33	ARBITRATE-(SLOT#9)
	+5S1	34	+551	34	+581
	ARBITRATE-(SLOT#4)				
36	ARBITRATE-(SLOT#1)	36	ARBITRATE-(SLOT#2)	36	ARBITRATE-(SLOT#3)
37	+28V (P/S #3) PFW- (P/S #1) PON+ (P/S #1) +SS1	37	+581		+28V (P/S #3)
38	PFW- (P/S #1)	38	PFW- (P/S #2)		PFW- (P/S #3)
39	PON+ (P/S #1)	39	PON+ (P/S #2)		PON+ (P/S #3)
40	+5S1	40	+551	40	+551

# HP 3000 SERIES 930 FRONT/REAR CABINET PCAS

								MPE	-XL										
	SLOTS	٥		1	2	3	4	5	6	7					_				
	FRONT CAB-NET	SYSTEM MON-TOR	POWER SUPPLY #1	RF	FLOAT-ZG PO-ZT		EU+	U	+ -	CA+	POWER SUPPLY #2		1	POWER SUPPLY #3		CPU & POSER			
							CON	FIGUI	RATIO	ON C	NLY		_						_
SLOTS R E A R C A B I N E T	M U X	2 HP-B MAG HAPE		4 LAN 8023 DTC/NS			1 CHARREL	2 CHARREL	3 CIAZZEL	4 CHAZZEL		7 N O T	3RD A	9 SED CONT	10 2ND A	11 AZD COZE	1ST MEMORY	MEMORY CO:	1/O & ME
SLOTS	8 LAN 8022 3 (NFT)NS)	•			12 A P	13 C-O BUFFER (3)	ADAPTER (C2)	ADAPTER (C1)	ADAPTER (C2)	ADAPTER (C1)		USED	ARRAY	CONTROLLER	ARRAY	CONTROLLER	ARRAY	CONTROLLER	MEMORY
_	CIC	) (CI	B) C	ARD	s			N	IID B	us (	(CTB)		ī		MEI	MORY	7		-

This section contains reference material to aid in troubleshooting the HP Precision Architecture Products.

#### Table 10-1. ASCII Code Table

## **ASCII Code Chart**

#### HOW TO USE THIS TABLE

- The table is sorted by character code, each code being represented by its decimal, octal, and hexadecimal
  equivalent.
- Each row of the table gives the ASCII and EBCDIC meaning of the character code, the ASCII → EBCDIC
  conversion code, and the Hollerith representation (punched card code) for the ASCII character.

The following examples describe several ways of using the table:

Example 1: Suppose you want to determine the ASCII code for the S character. Scan down the ASCII graphic column until you locate S, then look left on that row to find the character code = 36 (dec), 044 (oct), and 24 (hex). This is the code used by an ASCII device (terminal, printer, computer, etc.) to represent the S character. Its Hollerith punched card code is 11.3.8

Example 2: The character code 58 (hex) is the EBCDIC code for what character? Also, when 58 is converted to ASCII (for example, by ECOPY with the EBCDICIN option), what is the octal character code? First, locate 58 in the hex character code column and move right on that row to the EBCDIC graphic which is 5. The next column to the right gives the conversion to ASCII, 044. As a check, find 044 (bott) in the character code column, look right to the ASCII graphic column and note that S converted to EBCDIC is 133 (bott) which equals 58 (hex).

сн.	AR CO	DE		ASCI		EB	CDIC
Dec	Oct	Hex	Cnti/ Gph	to EBCDIC (Oct)	Hollerith	Cnti/ Gph	to ASCII (Oct)
0 1 2 3	000 001 002 003	00 01 02 03	NUL SOH STX ETX	000 001 002 003	12-0-1-8-9 12-1-9 12-2-9 12-3-9	NUL SOH STX ETX	000 001 002 003
4 5 6 7	004 005 006 007	04 05 06 07	EOT ENQ ACK BEL	067 055 056 057	7.9 0.5.8.9 0.6.8.9 0.7.8.9	PF HT LC DEL	234 011 206 177
8 9 10 11	010 011 012 013	08 09 0A 0B	BS HT LF VT	026 005 045 013	11-6-9 12-5-9 0-5-9 12-3-8-9	SMM VT	227 215 216 013
12 13 14 15	014 015 016 017	OC OD OE OF	FF CR SO SI	014 015 016 017	12 4 6 9 12 5 8 9 12 6 8 9 12 7 8 9	FF CR SO SI	014 015 016 017
16 17 18 19	020 021 022 023	10 11 12 13	DC1 DC2 DC3	020 021 022 023	12-11-1-8-9 11-1-9 11-2-9 11-3-9	DLE DC1 DC2 TM	020 021 022 023
20 21 22 23	024 025 026 027	14 15 16 17	DC4 NAK SYN ETB	074 075 062 046	489 589 29 069	RES NL BS IL	235 205 010 207
24 25 26 27	030 031 032 033	18 19 1A 1B	CAN EM SUB ESC	030 031 077 047	11 6 9 11 1 8 9 7 8 9 0 7 9	CAN CC CU1	030 031 222 217
28 29 30 31	034 035 036 037	1C 1D 1E 1F	FS GS RS US	034 035 036 037	11 4 8 9 11 5 8 9 11 6 8 9 11 7 8 9	IFS IGS IRS IUS	034 035 036 037
32 33 34 35	040 041 042 043	20 21 22 23	SP :	100 117 177 173	Blank 12 7 8 7 8 3 8	SOS FS	200 201 202 203
36	044 045	24 25	s	133 154	11 3 8 0 4 8	LF.	204 012

СН	AR CC	ĐE		ASC	11	ED	CDIC
Dec	Oct	Hex	Cntl/ Gph	to EBCDIC (Oct)	Hollerith	Cntl/ Gph	to ASCII (Oct)
48	060	30		360			220
49	061	31	Ιĭ	361	l i		221
50	062	32	2	362	2	SYN	026
51	063	33	3	363	3		223
52	064	34	4	364	۱ 4	PN	224
53	065	35	5	365	5	RS	225
54	066	36	6	366	6	υc	226
55	067	37	,	367	7	EOT	004
56	070	38	8	370	8		230
57	071	39	9	371	9		231
58	072	3A		172	2-8		232
59	073	38		136	11-6-8	CU3	233
60	074	3C	<	114	12-4-8	DC4	024
61	075	3D		176	6.8	NAK	025
62	076	3 E	>	156	0-6-8		236
63	077	3F	,	157	0-7-8	SUB	032
64	100	40	- 69	174	4.8	SP	040
65	101	41	Α.	301	12-1		240
66	102	42	В	302	12-2		241
67	103	43	С	303	12-3		242
68	104	44	D	304	12-4		243
69	105	45	E	305	12-5		244
70	106	46	F	306	12-6		245
71	107	47	G	307	12-7		246
72	110	48	н	310	128		247
73	111	49	,	311	12-9		250
74	112	4A		321	11.1	•	133
75	113	4B	ĸ	322	112		056
76	114	4C	L	323	113	<	074
77	115	4D	M	324	11.4	- (	050
78	116	4E	N	325	11.5	٠.	053
79	117	4F		326	11-6		041
80	120	50	Р	327	11.7	8	046
81	121	51	0	330	11.8		251
82	122	52 53	H S	331 342	0.2		252 253
						l i	
84	124	54	T	343	0.3		254
85	125	55	U	344	0.4		255

Table 10-1. ASCII Code Table (con't.)

СНА	R CO	O£		ASCI			CDIC
Dec	Oet	Hex	Cntl/ Gph	to EBCDIC (Oct)	Hollerith	Cntt/ Gph	10 ASCII (Oct)
38 39	046 047	26 27	6	120 175	12 58	EYB ESC	027 033
40 41	050 051	28	- ;	115 135	1258		210 211 212
42	052	29 2A 28		134 116	11 5 8 11 4 8 12 6 8	SM CU2	212 213
44 45	054 055	2C 2D		153	038		214 005
46 47	056 057	2E 2F		140 113 141	11 1238 01	ENQ ACK BF L	005 006
96 97	140	60		171	1.8	7	055
98 99	142	62 63	b c	201 202 203	12 0-1 12 0-2 12-0-3	l ′	057 262 263
100	144	64 65	d	204	12 0-4 12 0 5		264
101 102 103	145 146 147	66 67	1	205 206 207	1206	l	264 265 266 267
104	150	68	g h	210	12 0 8		270
105 106 107	151 152 153	69 6A 6B		211 221 222	12-0-9 12-11-1 12-11-2	:	271 174 054
108	154 155	6C		223	12 11 3 12 11 4		045
109 110 111	155 156 157	60 6E 64	m n	224 225 226	12-11-4 12-11-5 12-11-6	3	137 076 077
112	160		Р	227 230 231	12 11 7	Ė	
113 114 115	161 162 163	70 71 72 73	,	230 231 242	12 11 7 12 11 8 12 11 9 11 0 2	l	272 273 274 275
116	164	74	- 1	243	11-0-3	ŀ	276
118	166 167	75 76 77	**	744 245 246	11-0-4 11-0-5 11-0-6		277 300 301
120	170	78		247	1107		302
121 122 123	171 172 173	79 7A 7B	7	250 251 300	11-0-8 11-0-9 12-0	:	140 072 043
124	174	7C 7D		152 320			100 047
125 126 127	175 176 177	7D 7E 7F	DEL	241	12:11 11:0 11:0:1 12:7:9	l *	047 075 042
128	200	80	DEL	007	11-01-89	-	303
129 130 131	201 202 203	81 82 83	l	041 042 043	11-01-89 01-9 0-2-9 0-3-9	b c	141 142 143
132	204 205	84		044	0.4.9	a	144
133 134 135	205 206 207	85 86 87		025 006 027	11-5-9 12-6-9 11-7-9	1 9	145 146 147
136 137	210	88 89		050 051	089	'n	1150
138	211 212 213	8A 8B	1	051 052 053	0.89 0189 0289 0389	1	151 304 305
140	214 215	8C 8D		054 011	0.4.8.9		306 307
142	216 217	8E 8F		012	0.4-8-9 12-1-8-9 12-2-8-9 11-3-8-9		310 311
144	220 221 222	90	1	060 061 032	12110189 19 11289		312
146	222	91 92 93		032	11 2 8 9	k	152 153 154
148	774	94		064	4.9	m	155
150 151	225 226 227	95 96 97	1	065 066 010	5.9 6.9 12.8.9	000	156 157 160
152 153	220	98 99		020	89	,	161 162
154 155	231 232 233 234	9A 98	l	071 072 073	289	Ι΄.	313
156 157	235	9C 9D		004	1249		315 316
158 159	236 237	9E 9F		076 341	11019		317 320
160 161	240 241	A0 A1	I	101	12019 12029 12039 12049		321 176 163
162 163	242 243	A2 A3		103 104	12039	;	164
164 165	244 245	A4 A5 A6		105	12-0-5-9	ž	165
166 167	246 247	A6 A7		107	12069 12079 12089	*	166 167 170
168 169	250 251	A8 A9		111	1218	ÿ	171 172
170	252 253	Δē	1	122	12 18 12 11 19 12 11 29 12 11 39		322 323
172 173 174	254 255	AC AD		124 125	121149	1	324 325
174 175	256 257	AD AE AF		126 127	12:11:59 12:11:69 12:11:79	1	326 327

СН	AR CO	OE .		ASCI	1		СОНС
Dec	Oet	Hex	Cost/ Gph	EBCDIC (Oct)	Hellerith	Cnel/ Gph	to ASCH (Out)
86 87	126	56 57	v w	345 346	0.5		256 257
<b>88</b> 89	130	<b>58</b> 59	X Y Z	347	0-7 0-8		260
90 91	132	5A 5B	Z	351 112	0.9 12.28	s	261 135 044
92 93 94	134	5C 5D		340 132	0 2 8 11 2 8 11 7 8	1	052 051
94 95 176	136	5E 5F	] []	137 155	0.5-8	<u>`</u>	073 136
177 178 179	260 261 262 2.3	80 81 82 83	İ	130 131 142 143	12:11:89 11:1:8 11:0:2:9 11:0:3:9	l	330 331 332
180	2.3 264		ŀ	143 144 145	11-0-3-9	l	332 333 334
181 182 183	264 265 266 267	84 85 86 87	ŀ	145 146 147	11-0-4-9 11-0-5-9 11-0-6-9 11-0-7-9		334 335 336 337
	270	-	l	150	11-08-9 0-1-8 12-11-0		340
185 186 187	270 271 272 273	89 8A 88	,	150 151 160 161	12 11 0 1 9		340 341 342 343
188	274 275 276 277	BC BD	1	162 163 164	12-11-0-2-9 12-11-0-3-9 12-11-0-4-9 12-11-0-5-9		344 345 346
190 191	276 277	BE BF	L_	165	12-11-0-4-9 12-11-0-5-9	L	347
192 193 194	300 301 302 303	C0 C1 C2 C3		166 167 170	12-11-0-6-9 12-11-0-7-9 12-11-0-8-9	Â	173 101 102
195	304	C3 C4 C5		200	12-0-1-8	С	103
197 198	305 306	C6	ł	212 213 214	12028 12038 12048	D E F G	105
199 200	307 310	C7 C8		215 216	12-0-5-8	н	107
201 202 203	311 312 313	C9 CA CB		216 217 220 232	12-0-6-8 12-0-7-8 12-11-1-8 12-11-2-8	ï	111 350 351
204 205 206	314	CC CD CE CF		233	12:11:3.8	ı	352 353
207	315 316 317			234 235 236	12:11:4-8 12:11:5-8 12:11:6-8	7	354 355
208 209 210	320 321 322 323	DO D1 D2		237 240 252	12 11 7 8 11 0 1 8 11 0 2 8 11 0 3 8	741	175 112 113
211	323	D3		253	11038	K L	114
212 213 214	324 325 326	D4 D5 D6 D7		255 256	11048 11058 11068 11078	# N O P O R	116
215 216	327 330	07 D8 D9		257 260	12-11-0-1-8	o o	120 121 122
216 217 218 219	330 331 332 333	DA DB	l	260 261 262 263	12:11:0:1:8 12:11:0:1 12:11:0:2 12:11:0:3	^	122 356 357
220 221	334 335	DC DD		264 265	12:11:0:4		360 361
222	336 337	DE DF		266 267	12-11-0-4 12-11-0-5 12-11-0-6 12-11-0-7		362 363
224 225 226 227	340 341 342 343	E0 E1 E2		270 271 272 273	12 11 0 8 12 11 0 9 12 11 0 2 8 12 11 0 3 8		134 237 123 124
227	343	E3		273	12 11 0 3 8	S T	123 124 125
228 229 230	344 345 346	E4 E5 E6		274 275 276	12-11-0-4-8 12-11-0-5-8 12-11-0-6-8 12-11-0-7-8	×	126
231 232	347	E7		277	12-11-0-7-8	¥ × ×	130
233 234 235	350 351 352 353	E9 EA EB		312 313 314 315	120-2-8-9 120-3-8-9 120-4-8-9 120-5-8-9	Z	132 364 365
236 237	354 355	EC ED		316 317	120689	н	366 367
238 239 240	356 357	f E		332 333	12 11 289 12 11 389	L.	370 371
241 242	361 362	F0 F1 F2		334 335 336	12 11 48 9 12 11 58 9 12 11 68 9 12 11 78 9	0	060 061 062
243	363	F2 F3 F4 F5		337	1211.789	3	063
244 245 246	365 366 367	F6 F7		353 354	110289 110389 110489 110589	4 5 6 7	064 065 066
247 248 249 250	370	FR		355 356	110689	7 8 9	067
249 250 751	371 372 373	F9 FA F8		357 372 373	11 0 7 8 9 12 11 0 2 8 9 17 11 0 3 8 9	9	071 372 373
252 253 254	374 375	FC FD		374 375	12110489		374 375
254 255	376 377	6 t t		376 377	12110689	ŧο	37 <b>6</b> 377

# **SERVICE NOTES**



Notes

# Notes

## **READER COMMENT SHEET**

## HP 3000/930 and 9000/840 Computer Systems

# HP 3000/930 AND 9000/840 COMPUTER SYSTEMS CE Handbook

## 09740-90023 November 1986

We welcome your evaluation of this manual. Your comments and suggestions help us to improve our publications. Please explain your answers under Comments, below, and use additional pages if necessary.

as this manda teems	nically accurate?	☐ Yes ☐ No
Are the concepts an	d wording easy to understand?	Yes No
Is the format of this	s manual convenient in size, arrangement, and readability?	Yes No
Comments:		
	no postage stamp if mailed in the U.S. For locations outsicensure that your comments are forwarded.	de the U.S., your local HP
		de the U.S., your local HP  Date
representative will e		· · · · · · · · · · · · · · · · · · ·
representative will e		· · · · · · · · · · · · · · · · · · ·
FROM:		· · · · · · · · · · · · · · · · · · ·
FROM: Name Company		· · · · · · · · · · · · · · · · · · ·
FROM:  Name  Company		· · · · · · · · · · · · · · · · · · ·

FOLD



NO POSTAGE NECESSARY IF MAILED IN THE UNITED STATES

# **BUSINESS REPLY MAIL**

FIRST CLASS PERMIT NO. 718 CUPERTINO, CALIFORNIA

POSTAGE WILL BE PAID BY ADDRESSEE

Publications Manager Hewlett-Packard Company Information Technology Group 19111 Pruneridge Avenue Cupertino, California 95014-9974

.....

FOLD